EM78468

8-BIT Microcontroller

Product Specification

Doc. Version 1.1

ELAN MICROELECTRONICS CORP.

April 2005



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ELAN MICROELECTRONICS CORPORATION

Headquarters:

No. 12, Innovation Road 1 Science-based Industrial Park Hsinchu, Taiwan, 308 Tel: +886 3 563-9977

Fax: +886 3 563-9966

http://www.emc.com.tw

Hong Kong:

Elan (HK) Microelectronics Corporation, Ltd.

Rm. 1005B, 10/F Empire Centre 68 Mody Road, Tsimshatsui Kowloon, HONG KONG

Tel: +852 2723-3376 Fax: +852 2723-7780 elanhk@emc.com.hk

Europe:

Elan Microelectronics Corp. Elan Microelectronics (Europe)

Siewerdtstrasse 105 8050 Zurich, SWITZERLAND Tel:+41 43 299-4060 Fax:+41 43 299-4079

http://www.elan-europe.com

Shenzhen:

Shenzhen, Ltd.

SSMEC Bldg., 3F, Gaoxin S. Ave. Shenzhen Hi-Tech Industrial Park Shenzhen, Guandong, CHINA Tel: +86 755 2601-0565

Fax: +86 755 2601-0500

USA:

Elan Information Technology Group

1821 Saratoga Ave., Suite 250 Saratoga, CA 95070

USA

Tel: +1 408 366-8223 Fax: +1 408 366-8220

Shanghai:

Elan Microelectronics Shanghai Corporation, Ltd.

23/Bldg. #115 Lane 572, Bibo Road

Zhangjiang Hi-Tech Park Shanghai, CHINA Tel: +86 021 5080-3866 Fax: +86 021 5080-4600



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	Specification Revision History										
Version	Version Revision Description Date										
1.0	Initial version	2005//03/02									
1.1	Add LQFP 64 package	2005/04/11									



1 GENERAL DESCRIPTION

This LSI is an 8-bit RISC type microprocessor with high speed CMOS technology and low power consumption. Integrated onto a single chip are on chip watchdog timer (WDT), Data RAM, ROM, programmable real time clock counter, internal/external interrupt, power down mode, LCD driver, infrared transmitter function, and tri-state I/O. The EM78468 provides a seven option bits to accommodate user's requirements.

2 FEATURES

2.1 CPU

- Operating voltage and temperature range:
 - 2.2V ~ 5.5 V. (at 0°C~+70°C)
- Operation speed: DC ~ 10MHz clock input.
- Dual clock operation
 - High frequency oscillator can select among Crystal, RC, or PLL (phase lock loop)
 - Low frequency oscillator can select between Crystal or RC mode
- Totally 272 bytes SRAM
 - 144 bytes general purpose register
 - 128 bytes on chip data RAM
- 4K*13 bits MASK ROM
- Up to 28 bi-directional tri-state I/O ports
 - Typically, 12 bi-directional tri-state I/O ports.
 - 16 bi-directional tri-state I/O ports shared with LCD segment output pin.
- 8-level stack for subroutine nesting
- 8-bit real time clock/counter (TCC)
- One infrared transmitter/PWM generator function
- Four sets of 8 bits auto reload timer can be used as interrupt sources
 - Counter 1: independent down-count timer.
 - Counter 2, High Pulse Width Timer (HPWT), and Low Pulse Width Timer (LPWT) shared with IR function.
- Programmable free running on chip watchdog timer (WDT). This function can operate on Normal, Green and Idle mode.



Operation modes:

- Normal mode: The CPU operated on frequency of main oscillator (Fm)
- Green mode: The CPU operated on frequency sub-oscillator (Fs) and main oscillator (Fm) stop.
- Idle mode: CPU idle, LCD display remains working
- Sleep mode: whole chip stop working.
- Input port wake up function (PORT6, PORT8). Working on Idle and sleep mode.
- Eight interrupt sources, three external and five internal.
 - Internal interrupt source : TCC; Counter 1,2; High/Low pulse width timer.
 - External interrupt source: INT0, INT1 and Pin change wake-up (Port 6 and Port 8)

Packages:

- Dice form : 59 pin
- QFP-64 pin : EM78468Q (Body 14mm*20mm)
- LQFP-64 pin : EM78468AQ (Body 7mm*7mm)
- LQFP-44 pin : EM78468BQ (Body 10mm*10mm)
- QFP-44 pin : EM78468CQ (Body 10mm*10mm)

2.2 LCD Circuit

- Common driver pins: 4
- Segment driver pins: 32
- LCD Bias: 1/3, 1/2 bias
- LCD Duty: 1/4, 1/3, 1/2 duty

2.3 Applications

- Remote control for air conditioner
- Health care
- Home appliances



3 PIN ASSIGNMENTS



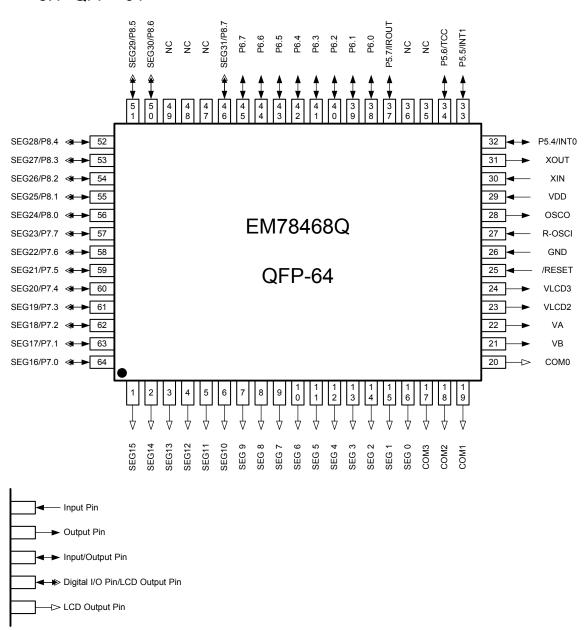


Fig. 1-(a) Pins Configuration for 64 Pin QFP Package

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3.2 LQFP - 64

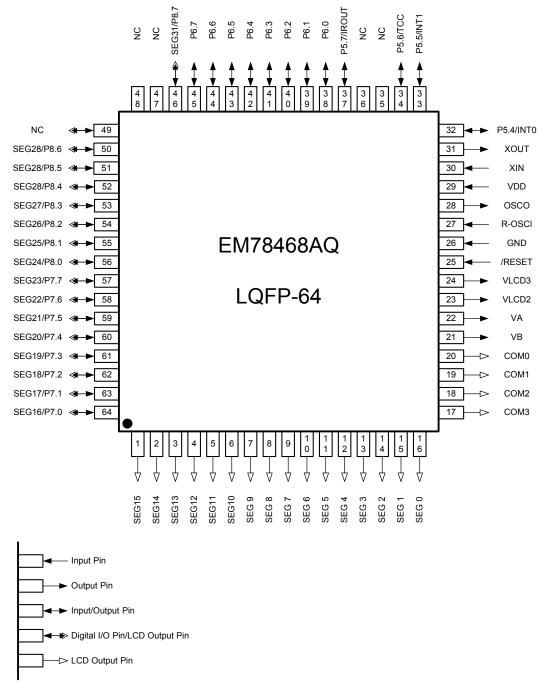


Fig. 1-(b) Pins Configuration for 64 Pin LQFP Package

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3.3 LQFP - 44

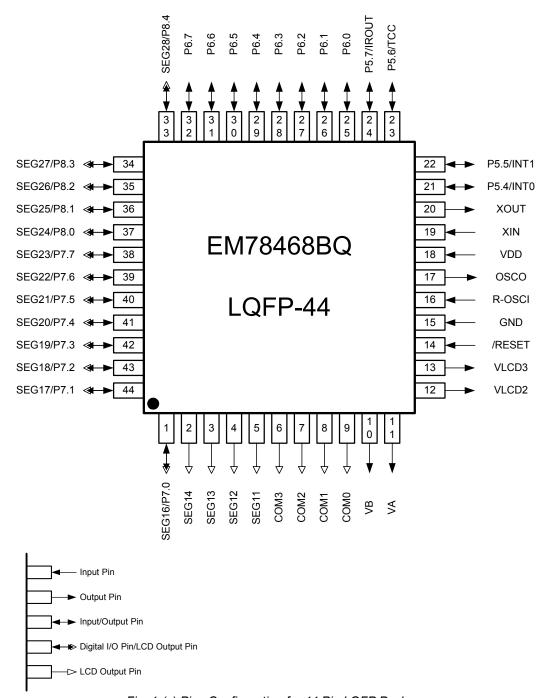


Fig. 1-(c) Pins Configuration for 44 Pin LQFP Package



3.4 QFP - 44

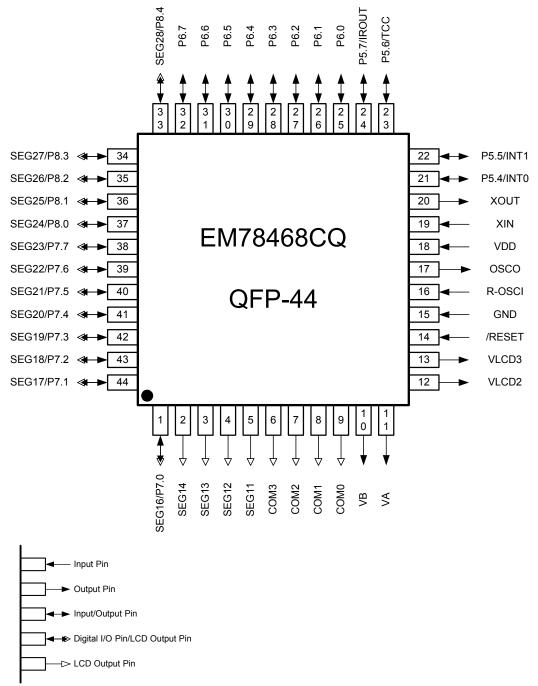


Fig. 1-(d) Pins Configuration for 44 Pin QFP Package



Table 1 (a) Pin Description for Package of QFP64 and LQFP64

	Table T (a) Fil	n Description	for Package of QFP64 and LQFP64
Pin	Pin Number	I/O type	Description
VDD	29		* Power supply pin
GND	26	I	* System ground pin
R-OSCI	27	I	 * In crystal mode: crystal input * In RC mode: resistor pull high. * In PLL mode: connect 0.01 μ F capacitance to GND * Connect 0.01 μ F capacitor to GND and code option select PLL mode when high oscillator is not use.
OSCO	28	0	* In crystal mode: crystal output * In RC mode: instruction clock output
Xin	30	I	 * In crystal mode:Input pin for sub-oscillator. Connect to a 32.768KHz crystal * RC mode: this pin is connected with a resistor to high level.
Xout	31	0	* In crystal: Connect to a 32.768KHz crystal * In RC mode: instruction clock output
/RESET	25	1	* Low active. If set as /RESET and remains at logic low, the devices will be reset
P5.4/INT0	32	I/O	* General purpose I/O pin. /external interrupt. * INT0 interruption source can be set to falling or rising edge by IOC71 register bit 7 (INT_EDGE). * Wake up from sleep mode and idle mode when the pin status changes.
P5.5/INT1	33	I/O	* General purpose I/O pin. /external interrupt. * Interruption source is a falling edge signal. * Wake up from sleep mode and idle mode when the pin status changes.
P5.6/TCC	34	I/O	* General purpose I/O/ external counter input * This pin works in normal/green/idle mode.
P5.7/IROUT	37	I/O	* General purpose I/O pin or IR/PWM mode output pin, * Capable of sinking 18mA/5V.
P6.0 ~ P6.7	38~45	I/O	* General purpose I/O pin. * Pull-high, pull-low and open drain function support. * All pins can wake up from sleep and idle modes when the pin status changes.
COM3~0	17~20	0	* LCD common output pin.
SEG0~SEG15	16~1	0	* LCD segment output pin.
SEG16/P7.0 ~ SEG23/P7.7	64 ~ 57	O/(I/O)	* LCD segment output pin. Can be shared with general purposes I/O pin
SEG24/P8.0 ~ SEG30/P8.6 SEG31/P8.7	56 ~ 50 46	O/(I/O)	* LCD segment output pin. Can be shared with general I/O pin * For general purpose I/O use, can wake up from sleep mode and idle mode when the pin status changes. * For general purposes I/O use, supports pull-high function.
VB	21	0	* Connect capacitors for LCD bias voltage
VA	22	0	* Connect capacitors for LCD bias voltage
VLCD2	23	0	* One of LCD bias voltage
VLCD3	24	0	* One of LCD bias voltage
NC	35~36 47~49		

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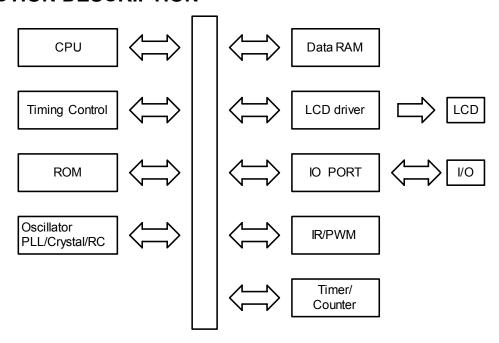


Table 1 (b) Pin Description for Package of QFP44 and LQFP44

	Table I (b) Pli	1 Description	for Package of QFP44 and LQFP44
Pin	Pin Number	I/O type	Description
VDD	18	I	* Power supply pin
GND	15	I	* System ground pin
R-OSCI	16	I	 * In crystal mode: crystal input * In RC mode: resistor pull high. * In PLL mode: connect 0.01 μ F capacitance to GND * Connect 0.01 μ F capacitance to GND and code option select PLL mode when high oscillator is not use.
osco	17	0	* In crystal mode: crystal output * In RC mode: instruction clock output
Xin	19	I	* In crystal mode:Input pin for sub-oscillator. Connect to a 32.768KHz crystal * RC mode: this pin is connected with a resistor to high level.
Xout	20	0	* In crystal: Connect to a 32.768KHz crystal * In RC mode: instruction clock output
/RESET	14	I	* Low active. If set as /RESET and remains at logic low, the devices will be reset
P5.4/INT0	21	I/O	* General purpose I/O pin. /external interrupt. * INT0 interruption source can be set to falling or rising edge by IOC71 register bit 7 (INT_EDGE). * Wake up from sleep mode and idle mode when the pin status changes.
P5.5/INT1	22	I/O	* General purpose I/O pin. /external interrupt. * Interruption source is a falling edge signal. * Wake up from sleep mode and idle mode when the pin status changes.
P5.6/TCC	23	I/O	* General purpose I/O/ external counter input * This pin works in normal/green/idle mode.
P5.7/IROUT	24	I/O	* General purpose I/O pin or IR/PWM mode output pin, * Capable of sinking 18mA/5V.
P6.0 ~ P6.7	25~32	I/O	* General purpose I/O pin. * Pull-high, pull-low and open drain function support. * All pins can wake up from sleep and idle modes when the pin status changes.
COM3~0	6~9	0	* LCD common output pin.
SEG11~SEG14	5~2	0	* LCD segment output pin.
SEG16/P7.0 SEG17/P7.1 ~	1 44 ~	O/(I/O)	* LCD segment output pin. Can be shared with general purposes I/O pin
SEG23/P7.7	38		
SEG24/P8.0 ~ SEG31/P8.4	37 ~ 33	O/(I/O)	* LCD segment output pin. Can be shared with general I/O pin * For general purpose I/O use, can wake up from sleep mode and idle mode when the pin status changes. * For general purposes I/O use, supports pull-high function.
VB	10	0	* Connect capacitors for LCD bias voltage
VA	11	0	* Connect capacitors for LCD bias voltage
VLCD2	12	0	* One of LCD bias voltage
VLCD3	13	0	* One of LCD bias voltage



4 FUNCTION DESCRIPTION



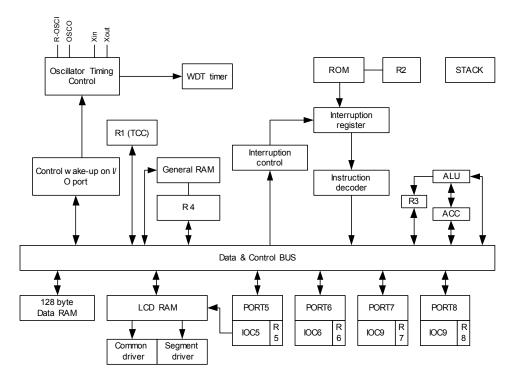


Fig. 2 System Block Diagram



4.1 Operational Registers

4.1.1 R0/IAR (Indirect Addressing Register) (Address: 00h)

R0 is not a physically implemented register. It is used as indirect addressing pointer. Any instruction using R0 as register actually accesses the data pointed by the RAM Select Register (R4).

4.1.2 R1/TCC (Time Clock /Counter) (Address: 01h)

Increases by an external signal edge applied to TCC, or by the instruction cycle clock.

Written and read by the program as any other register.

4.1.3 R2/PC (Program Counter) (Address: 02h)

- * The structure is depicted in Fig. 3
- * Generates 4K imes 13 on-chip ROM addresses to the relative programming instruction codes.
- * "JMP" instruction allows direct loading of the low 10 program counter bits.
- * "CALL" instruction loads the low 10 bits of the PC and PC+1, then push it into the stack.
- * "RET" ("RETL k", "RETI") instruction loads the program counter with the contents at the top of stack.
- * "MOV R2, A" allows the loading of an address from the A register to the PC. The contents of the ninth and tenth bits do not change.
- * "ADD R2, A" allows a relative address be added to the current PC.
- * The most significant bit (A10~A11) will be loaded with the content of bits PS0~PS1 in the Status register (R3) upon execution of a "JMP" or "CALL" instruction.



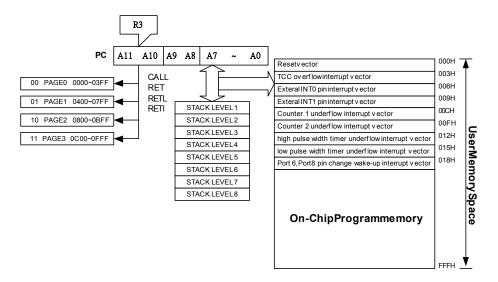
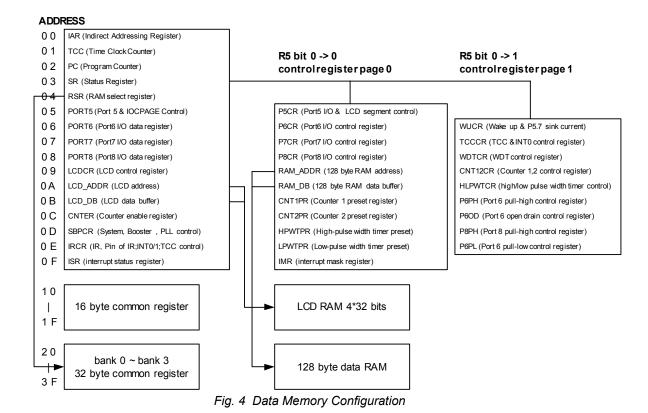


Fig. 3 Program Counter Organization



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4.1.4 R3/SR (Status Register) (Address: 03h)

Ві	it 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
		PS1	PS0	Т	Р	Z	DC	С

Bit 7: Not used

Bit 6, 5 (PS1 ~ PS0): Page select bits

PS1	PS0	ROM Page (Address)			
0	0	Page 0 (000H ~ 3FFH)			
0	1	Page 1 (400H ~ 7FFH)			
1	0	Page 2 (800H ~ BFFH)			
1	1	Page 3 (C00H ~ FFFH)			

PS0~PS1 are used to select a ROM page. User can use PAGE instruction (e.g. PAGE 1) or set PS1~PS0 bits to change ROM page. When executing a "JMP", "CALL", or other instructions which causes the program counter to be changed (e.g. MOV R2, A), PS0~PS1 are loaded into the 11th and 12th bits of the program counter where it selects one of the available program memory pages. Note that RET (RETL, RETI) instruction does not change the PS0~PS1 bits. That is, the return will always be to the page from where the subroutine was called, regardless of the current setting of PS0~PS1 bits.

Bit 4 (T): Time-out bit. Set to 1 by the "SLEP" and "WDTC" commands or during power up and reset to 0 by WDT timeout.

1			
EVENT	Т	P	REMARK
WDT wake up from sleep mode	0	0	
WDT time out (not sleep mode)	0	1	
/RESET wake up from sleep	1	0	
Power up	1	1	
Low pulse on /RESET	1	1	X: don't care

Bit 3 (P): Power down bit. Set to 1 during power on or by a "WDTC" command and reset to 0 by a "SLEP" command.

Bit 2 (Z): Zero flag

Bit 1 (DC): Auxiliary carry flag.

Bit 0 (C): Carry flag

4.1.5 R4/RSR (RAM Select Register)

(Address: 04h)

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
RBS1	RBS0	RSR5	RSR4	RSR3	RSR2	RSR1	RSR0

Bits 7 ~ 6 (RBS1 ~ RBS0) determine which bank is activated among the 4 banks. See the configuration of the data memory in Fig.4. Use BANK instruction (e.g. BABK 1) to change bank.



Bits 5 ~ 0 (RSR 5 ~ RSR 0) are used to select up to 64 registers (address: 00~3F) in the indirect addressing mode. If no indirect addressing is used, the RSR can be used as an 8-bit general purposes read/writer register.

4.1.6 R5/PORT5 (PORT 5 I/O Data and Page of Register Select) (Address: 05h)

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
R57	R56	R55	R54				IOCPAGE

Bit 7~4: 4-bits I/O registers of PORT5

User can use IOC50 register to define input or output each bit.

Bit 3~1: Not used

Bit 0 (IOCPAGE): change IOC5 ~ IOCF to another page, 0/1 => page0 / page1

IOCPAGE = "0": Page 0 (select register of IOC50 to IOCF0)

IOCPAGE = "1": Page 1 (select register of IOC61 to IOCE1)

4.1.7 R6/PORT6 (PORT 6 I/O Data Register)

(Address: 06h)

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
R67	R66	R65	R64	R63	R62	R61	R60

Bit 7~0: 8-bit I/O registers of PORT 6

User can use IOC60 register to define input or output each bit.

4.1.8 R7/PORT7 (PORT 7 I/O Data Register)

(Address: 07h)

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
R77	R76	R75	R74	R73	R72	R71	R70

Bit 7~0: 8-bit I/O registers of PORT 7

User can use IOC70 register to define input or output each bit.

4.1.9 R8/PORT8 (PORT 8 I/O Data Register)

(Address: 08h)

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
R87	R86	R85	R84	R83	R82	R81	R80

Bit 7~0: 8-bit I/O registers of PORT 8

User can use IOC80 register to define input or output each bit.



4.1.10 R9/LCDCR (LCD Control Register)

(Address: 09h)

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
BS	DS1	DS0	LCDEN		LCDTYPE	LCDF1	LCDF0

Bit 7 (BS): LCD bias select bit,

BS = "0": 1/2 bias

BS = "1": 1/3 bias

Bit 6 ~ 5 (DS1 ~ DS0): LCD duty select

DS1	DS0	LCD duty		
0	0	1/2 duty		
0	1	1/3 duty		
1	Х	1/4 duty		

Bit 4 (LCDEN): LCD enable bit.

LCDEN = "0": LCD circuit disable, all common/segment outputs are set to ground (GND) level.

LCDEN = "1": LCD circuit enable

Bit 3: Not used

Bit 2 (LCDTYPE): LCD drive waveform type select bit

LCDTYPE = "0": A type waveform

LCDTYPE = "1": B type waveform

Bit 1 ~ 0 (LCDF1 ~ LCDF0): LCD frame frequency control bits

LCDF1	LCDF0	LCD frame frequency (e.g. Fs=32.768KHz)						
LODFI	LODFO	1/2 duty	1/3 duty	1/4 duty				
0	0	Fs/(256*2)=64.0	Fs/(172*3)=63.5	Fs/(128*4) =64.0				
0	1	Fs/(280*2)=58.5	Fs/(188*3)=58.0	Fs/(140*4) =58.5				
1	0	Fs/(304*2)=53.9	Fs/(204*3)=53.5	Fs/(152*4) =53.9				
1 1		Fs/(232*2)=70.6	Fs/(156*3)=70.0	Fs/(116*4) =70.6				

Fs: sub-oscillator frequency

4.1.11 RA/LCD_ADDR (LCD Address)

(Address: 0Ah)

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0	0	0	LCD_A4	LCD_A3	LCD_A2	LCD_A1	LCD_A0

Bit 7 ~ 5: Not used, fixed to "0"



Bit 4 ~ 0 (LCDA4 ~ LCDA0): LCD RAM address

RA		RB (L	CD data l	ouffer)			
(LCD address)	Bit 7 ~4	Bit 3 (LCD_D3)	Bit 2 (LCD_D2)	Bit 1 (LCD_D1)	Bit 0 (LCD_D0)	Segment	
00H						SEG0	
01H						SEG1	
02H						SEG2	
						I	
1DH						SEG29	
1EH						SEG30	
1FH						SEG31	
Common	Х	COM3	COM2	COM1	СОМО		

4.1.12 RB/LCD_DB (LCD Data Buffer)

(Address: 0Bh)

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
				LCD_D 3	LCD_D 2	LCD_D 1	LCD_D 0

Bit 7 ~ 4: Not used

Bit 3~0 (LCD_D3 ~ LCD_D0): LCD RAM data transfer register

4.1.13 RC/CNTER (Counter Enable Register)

(Address: 0Ch)

	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
ĺ					LPWTEN	HPWTEN	CNT2EN	CNT1EN

Bit 7,5: Not used, must fixed to "0"

Bit 6,4: Not used

Bit 3(LPWTEN): low pulse width timer enable bit,

LPWTEN = "0": Disable LPWT. Count operation stop.

LPWTEN = "1": Enable LPWT. Count operation start.

Bit 2(HPWTEN): high pulse width timer enable bit

HPWTEN = "0": Disable HPWT. Count operation stop.

HPWTEN = "1": Enable HPWT. Count operation start.

Bit 1(CNT2EN): counter 2 enable bit

CNT2EN = "0": Disable Counter 2. Count operation stop.

CNT2EN = "1": Enable Counter 2. Count operation start.

Bit 0(CNT1EN): counter 1 enable bit

CNT1EN = "0": Disable Counter 1. Count operation stop.



CNT1EN = "1": Enable Counter 1. Count operation start.

4.1.14 RD/SBPCR (System, Booster and PLL Control Register) (Address: 0Dh)

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
	CLK2	CLK1	CLK0	IDLE	BF1	BF0	CPUS

Bit 7: Not used

Bit 6 ~ 4 (CLK2 ~ CLK0): main clock selection bits for PLL mode (code option select)

CLK2	CLK1	K1 CLK0 Main clock		Example Fs=32.768K		
0	0	0	Fs*130	4.26 MHz		
0	0	1	Fs*65	2.13 MHz		
0	1	0	Fs*65/2	1.065 MHz		
0	1 1		Fs*65/4	532 KHz		
1	Х	Х	Fs*244	8 MHz		

Bit 3 (IDLE): idle mode enable bit. This bit will decide the intended mode of the SLEP instruction.

IDLE="0"+SLEP instruction => sleep mode

IDLE="1"+SLEP instruction => idle mode

Example:IDLE mode: IDLE bit = "1" +SLEP instruction + NOP instruction

SLEEP mode: IDLE bit = "0" +SLEP instruction + NOP instruction

Bit 2 ~ 1 (BF1 ~ BF0): LCD booster frequency select bit to adjust VLCD 2,3 driving.

BF1	BF0	Booster frequency		
0	0	Fs		
0	1	Fs/4		
1	0	Fs/8		
1	1	Fs/16		

Bit 0 (CPUS): CPU oscillator source select, When CPUS=0, the CPU oscillator select sub-oscillator and the main oscillator is stopped.

CPUS = "0": sub-oscillator (Fs)

CPUS = "1": main oscillator (Fm)

^{*} NOP instruction must be added after SLEP instruction.



CPU Operation Mode

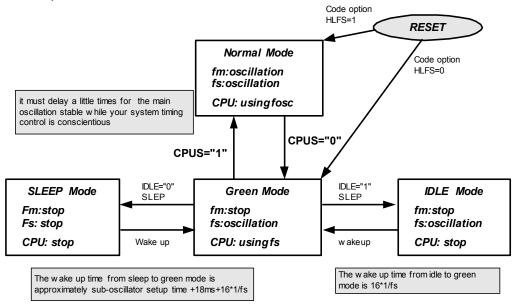


Fig. 5 CPU Operation Mode

4.1.15 RE/IRCR (IR and PORT 5 Setting Control Register) (Address: 0Eh)

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
IRE	HF	LGP		IROUTE	TCCE	EINT1	EINT0

Bit 7 (IRE): Infrared Remote Enable bit

IRE = "0": Disable IR/PWM function. The state of P5.7/IROUT pin is determined by bit 7 of IOC50 if it's for IROUT.

IRE = "1": Enable IR or PWM function.

Bit 6 (HF): High carry frequency.

HF = "0": For PWM application, disable H/W modulator function. IROUT waveform is created according to high-pulse and low-pulse time as determined by the high pulse and low pulse width timers respectively. The counter 2 is an independent auto reload timer.

HF = "1": For IR application mode, enable H/W modulator function, the low time sections of the generated pulse is modulated with the frequency Fcarrier. The frequency of Fcarrier provide by counter 2.

Bit 5 (LGP): IROUT for long time of low pulse.

LGP = "0": The high-pulse width timer register and low-pulse width timer is valid.

LGP = "1": The high-pulse width timer register is ignored. So the IROUT waveform is dependent on low-pulse width timer register only.

Bit 4: Not used

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(This specification is subject to change without further notice)



Bit 3 (IROUTE): Define the function of P5.7/IROUT pin.

IROUTE = "0": for bi-directional general I/O pin.

IROUTE = "1": for IR or PWM output pin, the control bit of P5.7 (bit 7 of IOC50) must be set to "0"

Bit 2 (TCCE): Define the function of P5.6/TCC pin.

TCCE = "0": for bi-directional general I/O pin.

TCCE = "1": for external input pin of TCC, the control bit of P5.6 (bit 6 of IOC50) must be set to "1"

Bit 1 (EINT1): Define the function of P5.5/INT1 pin.

EINT1 = "0": for bi-directional general I/O pin.

EINT1 = "1": for external interrupt pin of INT1, the control bit of P5.5 (bit 5 of IOC50) must be set to "1"

Bit 0 (EINT0): Define the function of P5.4/INT0 pin.

EINT0 = "0": for bi-directional general I/O pin.

EINT0 = "1": for external interrupt pin of INT0, the control bit of P5.4 (bit 4 of IOC50) must be set to "1"

4.1.16 Address: 0Fh; RF/ISR (Interrupt Status Register)

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
ICIF	LPWTF	HPWTF	CNT2F	CNT1F	INT1F	INT0F	TCIF

These bits are set to "1" when interrupt occurs respectively.

Bit 7 (ICIF): PORT 6, PORT 8, input status changed interrupt flag. Set when PORT6, PORT8 input changes.

Bit 6 (LPWTF): interrupt flag of internal low-pulse width timer underflow.

Bit 5 (HPWTF): interrupt flag of internal high-pulse width timer underflow.

Bit 4 (CNT2F): interrupt flag of internal counter 2 under-flow.

Bit 3 (CNT1F): interrupt flag of internal counter 1 underflow.

Bit 2 (INT1F): external INT1 pin interrupt flag.

Bit 1 (INT0F): external INT0 pin interrupt flag.

Bit 0 (TCIF): TCC timer overflow interrupt flag. Set when TCC timer overflows.

4.1.17 Address: 10h~3Fh;R10~R3F (General Purpose Register)

R10~R31F and R20~R3F (Banks 0~3) are general purposes register.



4.2 Special Purpose Registers

4.2.1 A (Accumulator)

- Internal data transfer, or instruction operand holding
- This is not an addressable register.

Registers of IOC Page 0 (IOC50 ~ IOCF0, Bit 0 of R5 = "0")

4.2.2 IOC50/P5CR (PORT 5 I/O and PORT 7, 8 for LCD Segment Control Register)

(Address: 05h, $Bit\ 0\ of\ R5 = "0")$

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
IOC57	IOC56	IOC55	IOC54	P8HS	P8LS	P7HS	P7LS

Bit 7~4(IOC57~54): PORT 5 I/O direction control register

IOC5x = "0": set the relative P5.x I/O pins as output

IOC5x = "1": set the relative P5.x I/O pin into high impedance (input pin)

Bit 3(P8HS): Switch to high nibble I/O of PORT 8 or to LCD segment output as share pins SEGxx/P8.x pins

P8HS = "0": select high nibble of PORT 8 as normal P8.4~P8.7

P8HS = "1": select LCD SEGMENT output as SEG 28~SEG 31 output

Bit 2(P8LS): Switch to low nibble I/O of PORT 8 or to LCD segment output as share pins SEGxx/P8.x pins

P8LS = "0": select low nibble of PORT 8 as normal P8.0~P8.3

P8LS = "1": select LCD SEGMENT output as SEG 24~SEG 27 output

Bit 1(P7HS): Switch to high nibble I/O of PORT 7 or to LCD segment output as share pins SEGxx/P7.x pins

P7HS = "0": select high nibble of PORT 7 as normal P7.4~P7.7

P7HS = "1": select LCD SEGMENT output as SEG 20~SEG 23 output

Bit 0(P7LS): Switch to low nibble I/O of PORT 7 or to LCD segment output as share pins SEGxx/P7.x pins

P7LS = "0": select low nibble of PORT 7 as normal P7.0~P7.3

P7LS = "1": select LCD SEGMENT output as SEG 16~SEG 19 output

4.2.3 IOC60/P6CR (PORT 6 I/O Control Register)

(Address: 06h, Bit 0 of R5 = "0")

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
IOC67	IOC66	IOC65	IOC64	IOC63	IOC62	IOC61	IOC60



Bit 7 (IOC67)~Bit 0(IOC60): PORT 6 I/O direction control register

IOC6x ="0": set the relative PORT6.x I/O pins as output

IOC6x ="1": set the relative PORT6.x I/O pin into high impedance (input pin)

4.2.4 IOC70/P7CR (PORT 7 I/O Control Register) (Address: 07h, Bit 0 of R5 = "0")

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
IOC77	IOC76	IOC75	IOC74	IOC73	IOC72	IOC71	IOC70

Bit 7 (IOC77)~Bit 0(IOC70): PORT 7 I/O direction control register

IOC7x = "0": set the relative PORT7.x I/O pins as output

IOC7x = "1": set the relative PORT7.x I/O pin into high impedance (input pin)

4.2.5 IOC80/P8CR (PORT 8 I/O Control Register) (Address: 08h, Bit 0 of R5 = "0")

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
IOC87	IOC86	IOC85	IOC84	IOC83	IOC82	IOC81	IOC80

Bit 7 (IOC 87)~Bit 0(IOC 80): PORT 8 I/O direction control register

IOC8x = "0": set the relative PORT8.x I/O pins as output

IOC8x = "1": set the relative PORT8.x I/O pin into high impedance (input pin)

4.2.6 IOC90/RAM_ADDR (128 Bytes General Purpose RAM Address) (Address: 09h, Bit 0 of R5 = "0")

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0	RAM_A6	RAM_A5	RAM_A4	RAM_A3	RAM_A2	RAM_A1	RAM_A0

Bit 7: Not used, fixed at "0"

Bit 6~0: 128 bytes RAM address

4.2.7 IOCA0/RAM_DB (128 Bytes General Purpose RAM Data Buffer) (Address: 0Ah, Bit 0 of R5 = "0")

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
RAM_D7	RAM_D6	RAM_D5	RAM_D4	RAM_D3	RAM_D2	RAM_D1	RAM_D0

Bit 7~0: 128 bytes RAM data transfer register

4.2.8 IOCB0/CNT1PR (Counter 1 Preset Register) (Address: 0Bh. Bit 0 of R5 = "0")

•		,		,			
Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0

Bit 7 ~ Bit 0: All are Counter 1 buffer that user can read and write. The Counter 1 is an 8-bit down-count timer/counter with 8-bit pre-scaler that is used as this register to preset



the counter and read preset value. The pre-scaler is set by IOC91 register. After an interruption, it will auto reload the preset value.

4.2.9 IOCCO/CNT2PR (Counter 2 Preset Register) (Address: 0Ch, Bit 0 of R5 = "0")

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0

Bit 7 ~ Bit 0: All are Counter 2 buffer that user can read and write. The Counter 2 is an 8-bit down-count timer with 8-bit pre-scaler that is used as this register to preset the counter and read preset value. The pre-scaler is set by IOC91 register. After an interruption, it will reload the preset value.

When IR output is enabled, this control register can obtain carrier frequency output.

If the Counter 2 clock source is equal to F_T-

Carrier frequency (Fcarrier) =
$$\frac{F_T}{2 * (preset _ value + 1) * prescaler}$$

4.2.10 IOCD0/HPWTPR (High-Pulse Width Timer Preset Register) (Address: 0Dh, Bit 0 of R5 = "0")

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0

Bit 7 ~ Bit 0: All are high-pulse width timer buffer that user can read and write. High-pulse width timer preset register is an eight-bit down-count timer with 8-bit pre-scaler that is used as IOCD0 to preset the counter and read preset value. The pre-scaler is set by IOCA1 register. After an interruption, it will reload the preset value.

For PWM or IR application, this control register is set as high pulse width.

If the high-pulse width timer source clock is F_T-

High pulse time =
$$\frac{\text{prescaler * (preset _ value + 1)}}{F_T}$$

4.2.11 IOCE0/LPWTPR (Low-Pulse Width Timer Preset Register) (Address: 0Eh, Bit 0 of R5 = "0")

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0

Bit 7 ~ Bit 0: All are low-pulse width timer buffer that user can read and write. Low-pulse width timer preset is an eight-bit down-count timer with 8-bit pre-scaler that is used as IOCE0 to preset the counter and read preset value. The pre-scaler is set by IOCA1 register. After an interruption, it will reload the preset value.

For PWM or IR application, this control register is set as low pulse width.

If the low-pulse width timer source clock is F_T-



Low pulse time =
$$\frac{prescaler * (preset _value + 1)}{F_T}$$

4.2.12 IOCF0/IMR (Interrupt Mask Register)

(Address: 0Fh, Bit 0 of R5 = "0")

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
ICIE	LPWTE	HPWTE	CNT2E	CNT1E	INT1E	INT0E	TCIE

Bit 7~Bit 0: interrupt enable bit. Enable interrupt source respectively.

0: disable interrupt

1: enable interrupt

IOCF0 register is readable and writable.

Registers of IOC Page 1 (IOC61 ~ IOCE1, Bit 0 of R5 = "1")

4.2.13 IOC61/WUCR (Wake Up and sink current of P5.7/IROUT Control Register)

(Address: 06h, Bit 0 of R5 = "1")

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
IROCS				/WUE8H	/WUE8L	/WUE6H	/WUE6L

Bit 7: IROCS: IROUT/PORT5.7 output sink current set

IROCS	P5.7/IROUT Sink current				
IROCS	VDD=5V	VDD=3V			
0	9 mA	6 mA			
1	18 mA	12 mA			

Bit 6,5,4: Not used

Bit 3 (/WUE8H): 0/1=> enable/disable P8.4~P8.7 pin change wake up function

Bit 2 (/WUE8L): 0/1=> enable/disable P8.0~P8.3 pin change wake up function

Bit 1 (/WUE6H): 0/1=> enable/disable P6.4~P6.7 pin change wake up function

Bit 0 (/WUE6L): 0/1=> enable/disable P6.0~P6.3 pin change wake up function

Port 6 and Port 8 must avoid input floating when wakeup function is enabled.
The initial state of wakeup function is enabled.

4.2.14 IOC71/TCCCR (TCC Control Register)

(Address: 07h, Bit 0 of R5 = "1")

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
INT_EDGE	INT	TS	TE	PSRE	TCCP2	TCCP1	TCCP0

Bit 7 (INT_EDGE):

INT_EDGE = "0": Interrupt on rising edge of P5.4/INT0 pin



INT_EDGE = "1": Interrupt on falling edge of P5.4/INT0 pin

Bit 6 (INT): INT enable flag, this bit is read only

INT = "0": interrupt masked by DISI or hardware interrupt

INT = "1": interrupt enabled by ENI/RETI instructions

Bit 5 (TS): TCC signal source

TS = "0": internal instruction cycle clock

TS = "1": transition on TCC pin, TCC period > internal instruction clock period

Bit 4 (TE): TCC signal edge

TE = "0": increment by TCC pin rising edge

TE = "1": increment by TCC pin falling edge

Bit 3~0 (PSRE, TCCP2~TCCP0): TCC pre-scaler bits.

PSRE	TCCP2	TCCP1	TCCP0	TCC Rate
0	Х	Х	X	1:1
1	0	0	0	1:2
1	0	0	1	1:4
1	0	1	0	1:8
1	0	1	1	1:16
1	1	0	0	1:32
1	1	0	1	1:64
1	1	1	0	1:128
1	1	1	1	1:256

4.2.15 IOC81/WDTCR (WDT Control Register)

(Address: 08h, Bit 0 of R5 = "1")

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
				WDTE	WDTP2	WDTP1	WDTP0

Bit 7 ~ 4:Not used

Bit 3 (WDTE): watchdog timer enable. This control bit is used to enable the Watchdog timer,

WDTE = "0": Disable WDT function.

WDTE = "1": enable WDT function.



Bit $2 \sim 0$ (WDTP2 \sim WDTP0): watchdog timer pre-scaler bits. The WDT source clock is sub-oscillation frequency.

WDTP2	WDTP1	WDTP0	WDT rate
0	0	0	1:1
0	0	1	1:2
0	1	0	1:4
0	1	1	1:8
1	0	0	1:16
1	0	1	1:32
1	1	0	1:64
1	1	1	1:128

4.2.16 IOC91/CNT12CR (Counter 1, 2 Control Register) (Address: 09h, Bit 0 of R5 = "1")

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
CNT2S	CNT2P2	CNT2P1	CNT2P0	CNT1S	CNT1P2	CNT1P1	CNT1P0

Bit 7(CNT2S):Counter 2 clock source select 0/1 => Fs/ Fm*

(*Fs: sub-oscillator clock, Fm: main-oscillator clock)

Bit 6~4(CNT2P2~CNT2P0): Counter 2 pre-scaler select bits

The North I of the State of the							
CNT2P2	CNT2P1	CNT1P0	Counter 2 scale				
0	0	0	1:2				
0	0	1	1:4				
0	1	0	1:8				
0	1	1	1:16				
1	0	0	1:32				
1	0	1	1:64				
1	1	0	1:128				
1	1	1	1:256				

Bit 3(CNT1S):Counter 1 clock source select 0/1 => Fs/ Fm

Bit 2~0 (CNT1P2~CNT1P0): Counter 1 pre-scaler select bits

CNT1P2	CNT1P1	CNT1P0	Counter 1 scale
0	0	0	1:2
0	0	1	1:4
0	1	0	1:8
0	1	1	1:16
1	0	0	1:32
1	0	1	1:64
1	1	0	1:128
1	1	1	1:256

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4.2.17 IOCA1/HLPWTCR (High/Low Pulse Width Timer Control Register)

(Address: 0Ah, Bit 0 of R5 = "1")

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
LPWTS	LPWTP2	LPWTP1	LPWTP0	HPWTS	HPWTP2	HPWTP1	HPWTP0

Bit 7(LPWTS): low-pulse width timer clock source select 0/1 -> Fs/ Fm*

(*Fs: sub-oscillator clock, Fm: main-oscillator clock)

Bit 6~4 (LPWTP2~ LPWTP0): low-pulse width timer pre-scaler select bits

LPWTP2	LPWTP1	LPWTP0	Low-pulse width timer scale
0	0	0	1:2
0	0	1	1:4
0	1	0	1:8
0	1	1	1:16
1	0	0	1:32
1	0	1	1:64
1	1	0	1:128
1	1	1	1:256

Bit 3(HPWTS): high-pulse width timer clock source select 0/1 -> Fs/ Fm

Bit 2~0(HPWTP2~ HPWTP0): high-pulse width timer pre-scaler select bits

HPWTP2	HPWTP1	HPWTP0	High-pulse width timer scale
0	0	0	1:2
0	0	1	1:4
0	1	0	1:8
0	1	1	1:16
1	0	0	1:32
1	0	1	1:64
1	1	0	1:128
1	1	1	1:256

4.2.18 IOCB1/P6PH (PORT 6 Pull High Control Register) (Address: 0Bh, Bit 0 of R5 = "1")

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
PH67	PH66	PH65	PH64	PH63	PH62	PH61	PH60

Bit 7 ~ Bit 0 (PH67 ~ PH60): The enable bits of PORT 6 pull high function.

PH6x = "0": disable pin of P6.x internal pull-high resistor function

PH6x = "1": enable pin of P6.x internal pull-high resistor function



4.2.19 IOCC1/P6OD (PORT 6 Open Drain Control Register) (Address: 0Ch, Bit 0 of R5 = "1")

Bit 7	Bit 7 Bit 6		Bit 5 Bit 4		Bit 2	Bit 1	Bit 0	
OP67	OP66	OP65	OP64	OP63	OP62	OP61	OP60	

Bit 7 ~ Bit 0: The enable bits of PORT 6 open drain function.

OD6x = "0": disable pin of P6.x open drain function

OD6x = "1": enable pin of P6.x open drain function

4.2.20 IOCD1/P8PH (PORT 8 Pull High Control Register) (Address: 0Dh, Bit 0 of R5 = "1")

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
PH87	PH86	PH85	PH84	PH83	PH82	PH81	PH80

Bit 7 ~ Bit 0: The enable bits of PORT 8 pull-high function.

PH8x = "0": disable pin of P8.x internal pull-high resistor function

PH8x = "1": enable pin of P8.x pull-high resistor function

4.2.21 IOCE1/P6PL (PORT 6 Pull-Low Control Register) (Address: 0Eh, Bit 0 of R5 = "1")

Bit 7	Bit 6	Bit 6 Bit 5		Bit 3	Bit 2	Bit 1	Bit 0	
PL67	PL66	PL65	PL64	PL63	PL62	PL61	PL60	

Bit 7 ~ Bit 0: The enable bits of PORT 6 pull low function.

PL6x = "0": disable pin of P6.x internal pull-low resistor function

PL6x = "1": enable pin of P6.x internal pull-low resistor function



4.3 TCC and WDT Pre-scaler

Two 8-bit counters are available as pre-scalers for the TCC (Time Clock Counter) and WDT (Watch Dog Timer). The TCCP2~TCCP0 bits of the IOC71 register are used to determine the ratio of the TCC pre-scaler. Likewise, the WDTP2~WDTP0 bits of the IOC81 register are used to determine the WDT pre-scaler. The TCC pre-scaler (TCCP2~TCCP0) is cleared by the instructions each time they are written into TCC, while the WDT pre-scaler is cleared by the "WDTC" and "SLEP" instructions. Fig.7 depicts the circuit diagram of TCC and WDT.

R1 (TCC) is an 8-bit timer/counter. The clock source of TCC can be selected by internal instruction clock or external signal input (edge selectable from the TCC control register). If TCC signal source is from internal instruction clock, TCC will increase by 1 at every instruction cycle (without pre-scaler). If TCC signal source is from external clock input, TCC will increase by 1 at every falling edge or rising edge of the TCC pin.

The watchdog timer is a free running sub-oscillator. The WDT will keep on running even after the oscillator driver has been turned off. During Normal mode, Green mode, or Idle mode operation, a WDT time-out (if enabled) will cause the device to reset. The WDT can be enabled or disabled at any time during the Normal mode and Green mode by software programming. Refer to WDTE bit of IOC81 register. The WDT time-out period is equal to (pre-scaler*256/ (Fs/2)).

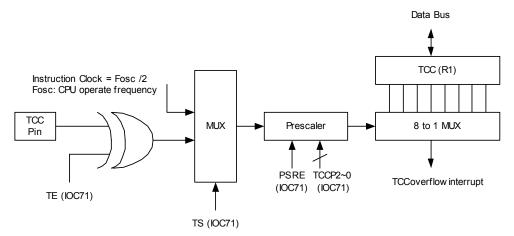


Fig. 7(a) Block Diagram of TCC



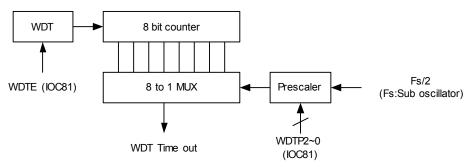
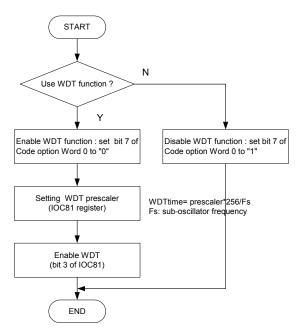


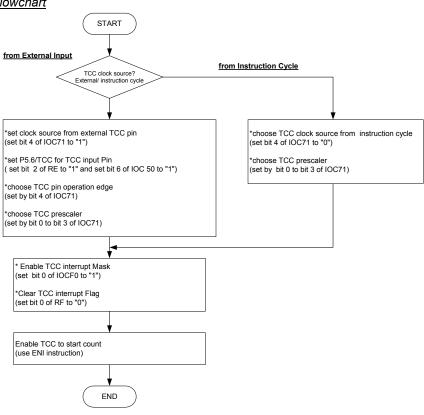
Fig. 7(b) Block Diagram of WDT



WDT setting flowchart



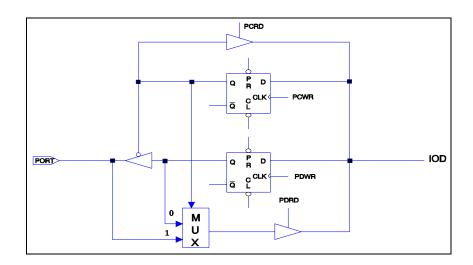
TCC setting flowchart





4.4 I/O Ports

The I/O registers, (PORT 5, PORT 6, PORT 7 and PORT 8), are bi-directional tri-state I/O ports. PORT 6 and PORT 8 are pulled-high internally by software; PORT 6 is also pulled-low internally by software. Furthermore, PORT 6 has its open-drain output also through software. PORT 6 and PORT 8 features an input status changed interrupt (or wake-up) function and is pulled-high by software. Each I/O pin can be defined as "input" or "output" pin by the I/O control register (IOC50 ~ IOC80). The I/O registers and I/O control registers are both readable and writable. The I/O interface circuits are shown in Fig. 8



NOTE: Open-drain, pull high, and pull down are not shown in the figure.

Fig. 8 The Circuit of I/O Port and I/O Control Register for PORT 5 ~ 8



4.5 RESET and Wake-up

A reset can be activated by

- POR (Power On Reset)
- WDT timeout. (if enabled)
- /RESET pin go to low.

Note: The power on reset circuit is always enabled. It will reset CPU at about 1.9V.

Once reset occurs, the following functions are performed

- The oscillator is running, or will be started.
- The program counter (R2/PC) is set to all "0".
- All I/O port pins are configured as input mode (high-impedance state).
- The TCC/Watchdog timer and pre-scaler are cleared.
- When power on, the Bit 5, 6 of R3 and the upper 2 bits of R4 are cleared.
- Bits of the IOC71 register are set to all "1" except for Bit 6 (INT flag).
- For other registers, see Table 2 below.



Table 2 Summary of the Initialized Values for Registers

Address	Name	Reset Type	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Audress	Name									
		Bit Name Power-On	10C57 1	1OC56	1OC55	10C54	P8HS 0	P8LS 0	P7HS 0	P7LS 0
0x05	IOC50	/RESET and WDT	1	1	1	1	0	0	0	0
	(P5CR)	Wake-Up from Pin						-		-
		Change	Р	Р	Р	Р	Р	Р	Р	Р
		Bit Name	IOC67	IOC66	IOC65	IOC64	IOC63	IOC62	IOC61	IOC60
	IOC60	Power-On	1	1	1	1	1	1	1	1
0x06	(P6CR)	/RESET and WDT	1	1	1	1	1	1	1	1
	(1 0011)	Wake-Up from Pin	Р	Р	Р	Р	Р	Р	Р	Р
		Change	Ţ.							· ·
		Bit Name Power-On	10C77	10C76	10C75	10C74	10C73	10C72	10C71	10C70
0x07	IOC70 (P7CR)	/RESET and WDT	1	1	1	1	1	1	1	1
0,07		Wake-Up from Pin								
		Change	Р	Р	Р	Р	Р	Р	Р	Р
		Bit Name	IOC87	IOC86	IOC85	IOC84	IOC83	IOC82	IOC81	IOC80
	IOC80	Power-On	1	1	1	1	1	1	1	1
0x08	(P8CR)	/RESET and WDT	1	1	1	1	1	1	1	1
	(1. 551.1)	Wake-Up from Pin	Р	Р	Р	Р	Р	Р	Р	Р
		Change	· ·		·	-	-	-	-	-
		Bit Name	X				RAM_A3		_	RAM_A0
0x09	IOC90	Power-On /RESET and WDT	0	0	0	0	0	0	0	0
0,09	(RAM_ADDR)	Wake-Up from Pin						_		
		Change	Р	Р	Р	Р	Р	Р	Р	Р
		Bit Name	RAM D7	RAM D6	RAM D5	RAM D4	RAM D3	RAM D2	RAM D1	RAM D0
	10000	Power-On	U	U	U	U	U	U	U	U
0x0A	(RAM_DB)	/RESET and WDT	Р	Р	Р	Р	Р	Р	Р	Р
		Wake-Up from Pin	Р	Р	Р	Р	Р	Р	Р	Р
		Change								
	IOCB0 (CNT1PR)	Bit Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x0B		Power-On /RESET and WDT	0	0	0	0	0	0	0	0
UXUB		Wake-Up from Pin						_		
		Change	Р	Р	Р	Р	Р	Р	Р	Р
		Bit Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
	IOCC0	Power-On	0	0	0	0	0	0	0	0
0x0C	(CNT2PR)	/RESET and WDT	0	0	0	0	0	0	0	0
	(CIVIZI IV)	Wake-Up from Pin	Р	Р	Р	Р	Р	Р	Р	Р
		Change		· ·				-		
	IOCD0 (HPWTPR)	Bit Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x0D		Power-On /RESET and WDT	0	0	0	0	0	0	0	0
OXOB		Wake-Up from Pin						_		
		Change	Р	Р	Р	Р	Р	Р	Р	Р
		Bit Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
	IOCE0	Power-On	0	0	0	0	0	0	0	0
0x0E	(LPWTPR)	/RESET and WDT	0	0	0	0	0	0	0	0
		Wake-Up from Pin	Р	Р	Р	Р	Р	Р	Р	Р
		Change	IOIE					INITAE		
	IOCF0 (IMR)	Bit Name Power-On	ICIE 0	LPWTE 0	HPWTE 0	CNT2E 0	CNT1E 0	INT1E 0	INT0E 0	TCIE 0
0x0F		/RESET and WDT	0	0	0	0	0	0	0	0
OXO!		Wake-Up from Pin								
		Change	Р	Р	Р	Р	Р	Р	Р	Р
		Bit Name	IROCS	Х	Х	X	/WUE8H	/WUE8L	/WUE6H	/WUE6L
	IOC61	Power-On	0	U	U	U	0	0	0	0
0x06	(MILIOD)	/RESET and WDT	0	U	U	U	0	0	0	0
		Wake-Up from Pin	Р	U	U	U	Р	Р	Р	Р
		Change	-							
		Bit Name Power-On	INT_EDGE	INT	TS	TE 1	PSRE 1	TCCP2	TCCP1	TCCP0
0x07		/RESET and WDT	1	0	1	1	1	1	1	1
0.07		Wake-Up from Pin								
		Change	Р	Р	Р	Р	Р	Р	Р	Р
L			i							

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Address	Name	Reset Type	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
		Bit Name	Х	Х	Х	Х	WDTE	WDTP2	WDTP1	WDTP0
	IOC81	Power-On	U	U	U	U	0	1	1	1
80x0	(WDTCR)	/RESET and WDT	U	U	U	U	0	1	1	1
	(***=**********************************	Wake-Up from Pin Change	U	U	U	U	Р	Р	Р	Р
		Bit Name	CNT2S	CNT2P2	CNT2P1	CNT2P0	CNT1S	CNT1P2	CNT1P1	CNT1P0
	IOC91	Power-On	0	0	0	0	0	0	0	0
0x09	(CNT12CR)	/RESET and WDT	0	0	0	0	0	0	0	0
		Wake-Up from Pin Change	Р	Р	Р	Р	Р	Р	Р	Р
		Bit Name	LPWTS	LPWTP2 0	LPWTP1		HPWTS	HPWTP2	HPWTP1	HPWTP0
0x0A	IOCA1	Power-On /RESET and WDT	0	0	0	0	0	0	0	0
UNUA	(HLPWTCR)	Wake-Up from Pin			-				_	
		Change	P	Р	Р	Р	Р	Р	P	Р
		Bit Name	PH67	PH66	PH65	PH64	PH63	PH62	PH61	PH60
0x0B	IOCB1	Power-On	0	0	0	0	0	0	0	0
UXUB	(P6PH)	/RESET and WDT Wake-Up from Pin	<u>U</u> Р	P	P	P	P	P	P	P
		Change	0067	ODec	ODGE	OD64	ODea	ODea	0064	ODGO
		Bit Name	OP67	OP66	OP65	OP64	OP63	OP62	OP61	OP60
0x0C	IOCC1	Power-On /RESET and WDT	0	0	0	0	0	0	0	0
0.000	(P6OD)	Wake-Up from Pin	<u> </u>	P	P	P	P	P	P	P
		Change Bit Name	PH87	PH86	PH85	PH84	PH83	PH82	PH81	PH80
		Power-On	0	0	0	0	0	0	0	0
0x0D	IOCD1	/RESET and WDT	0	0	0	0	0	0	0	0
OXOD	(P8PH)	Wake-Up from Pin Change	P	P	P	P	P	P	P	P
		Bit Name	PL67	PL66	PL65	PL64	PL63	PL62	PL61	PL60
	IOCE1	Power-On	0	0	0	0	0	0	0	0
0x0E		/RESET and WDT	0	0	0	0	0	0	0	0
	(P6PL)	Wake-Up from Pin Change	Р	Р	Р	Р	Р	Р	Р	Р
		Bit Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
	DO.	Power-On	U	U	U	U	U	U	U	U
0x00	R0 (IAR)	/RESET and WDT	Р	Р	Р	Р	Р	Р	Р	Р
	(IAIX)	Wake-Up from Pin Change	Р	Р	Р	Р	Р	Р	Р	Р
		Bit Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
	R1	Power-On	0	0	0	0	0	0	0	0
0x01	(TCC)	/RESET and WDT	0	0	0	0	0	0	0	0
	(100)	Wake-Up from Pin Change	Р	Р	Р	Р	Р	Р	Р	Р
		Bit Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
	R2	Power-On	0	0	0	0	0	0	0	0
0x02	(PC)	/RESET and WDT	0	0	0	0	0	0	0	0
	(* 2)	Wake-Up from Pin Change	Ju	mp to add	ress 0x00	18 or conti		cute next	instruction	ı
		Bit Name	X	PS1	PS0	T	P	Z	DC	С
0.00	R3	Power-On	U	0	0	1	1	U	U	U
0x03	(SR)	/RESET and WDT	U	0	0	t	t	Р	Р	Р
	. ,	Wake-Up from Pin Change	U	Р	Р	t	t	Р	Р	Р
		Bit Name	Bank1	Bank0						
0.40.4	R4	Power-On	0	0	U	U	U	U	U	U
0x04	(RSR)	/RESET and WDT Wake-Up from Pin	0 P	0 P	P P	P P	P P	P P	P P	P P
		Change								
		Bit Name	R57	R56	R55	R54	X	X	X	IOCPAGE
0,05	R5	Power-On	1	1	1	1	U	U	U	0
0x05	(PORT5)	/RESET and WDT Wake-Up from Pin	1 P	1 P	1 P	1 P	U	U	U	0 P
		Change	•				,	J		

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(This specification is subject to change without further notice)



Address	Name	Reset Type	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
		Bit Name	R67	R66	R65	R64	R63	R62	R61	R60
	Do	Power-On	1	1	1	1	1	1	1	1
0x06	R6 (PORT6)	/RESET and WDT	1	1	1	1	1	1	1	1
	(PORTO)	Wake-Up from Pin Change	P	Р	Р	Р	Р	Р	Р	Р
		Bit Name	R77	R76	R75	R74	R73	R62	R71	R70
	D-7	Power-On	1	1	1	1	1	1	1	1
0x7	R7	/RESET and WDT	1	1	1	1	1	1	1	1
	(PORT7)	Wake-Up from Pin Change	Р	Р	Р	Р	Р	Р	Р	Р
		Bit Name	R87	R86	R85	R84	R83	R82	R81	R80
	D0	Power-On	1	1	1	1	1	1	1	1
0x8	R8 (PORT8)	/RESET and WDT	1	1	1	1	1	1	1	1
	(PORTO)	Wake-Up from Pin Change	Р	Р	Р	Р	Р	Р	Р	Р
		Bit Name	BS	DS1	DS0	LCDEN	Х	LCDTYPE	LCDF1	LCDF0
	D0	Power-On	1	1	0	0	U	0	0	0
0x9	R9	/RESET and WDT	1	1	0	0	U	0	0	0
	(LCDCR)	Wake-Up from Pin Change	Р	Р	Р	Р	U	Р	Р	Р
		Bit Name	Χ	Х	Х	LCD A4	LCD_A3	LCD A2	LCD A1	LCD A0
		Power-On	0	0	0	0	0	0	0	0
0xA	RA	/RESET and WDT	0	0	0	0	0	0	0	0
	(LCD_ADDR)	Wake-Up from Pin Change	P	Р	Р	Р	Р	P	Р	P
	RB (LCD_DB)	Bit Name	X	Х	Х	Х	LCD_D 3	LCD_D 2	LCD_D 1	LCD_D 0
		Power-On	U	U	U	U	U	U	U	Ü
0xB		/RESET and WDT	Ü	Ü	Ü	Ü	P	P	P	P
		Wake-Up from Pin Change	U	U	U	U	Р	Р	Р	Р
		Bit Name	Х	Х	Х	Х	LPWTEN	HPWTEN	CNT2EN	CNT1EN
	D0	Power-On	0	1	0	0	0	0	0	0
0xC	RC (CNTED)	/RESET and WDT	0	1	0	0	0	0	0	0
	(CNTER)	Wake-Up from Pin Change	Р	Р	0	Р	Р	Р	Р	Р
		Bit Name	Х	CLK2	CLK1	CLK0	IDLE	BF1	BF0	CPUS
	- DD	Power-On	U	0	0	0	1	0	0	*1
0xD	RD (CDDCD)	/RESET and WDT	U	0	0	0	1	0	0	*1
	(SBPCR)	Wake-Up from Pin Change	U	Р	Р	Р	Р	Р	Р	Р
		Bit Name	IRE	HF	LGP	Х	IROUTE	TCCE	EINT1	EINT0
		Power-On	0	0	0	Ü	0	0	0	0
0xE	RE	/RESET and WDT	0	0	0	Ü	0	0	0	0
	(IRCR)	Wake-Up from Pin Change	Р	Р	Р	U	Р	Р	Р	Р
		Bit Name	ICIF	LPWTF	HPWTF	CNT2F	CNT1F	INT1F	INT0F	TCIF
		Power-On	0	0	0	0	0	0	0	0
0xF	RF (IOD)	/RESET and WDT	0	0	0	0	0	0	0	0
23	(ISR)	Wake-Up from Pin Change	N	Р	Р	Р	Р	P	P	P
		Bit Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
		Power-On	U	U	U	U	U	U	U	U
0x10~0x3F	R10~R3F	/RESET and WDT	P	P	P	P	P	P	P	P
	IX TO TAUE	Wake-Up from Pin Change	P	P	P	P	P	P	P	P
										_

X: not used. U: unknown or don't care. P: previous value before reset. -: Not defined

t: check R3 register explain. N: Monitors interrupt operation status.

Note 1: This bit is equal to code option HLFS bit data



The controller can be awakened from sleep mode and idle mode. The wake-up signals are listed as follows:

Wakeup signal	Sleep mode	ldle mode	Green mode	Normal mode
TCC time out IOCF0 bit0=1	х	*1 Wake-up + interrupt + next instruction	Interrupt	Interrupt
INT0 pin IOCF0 bit1=1	Wake-up + interrupt + next instruction	Wake-up + interrupt + next instruction	Interrupt	Interrupt
INT1 pin IOCF0 bit2=1	Wake-up + interrupt + next instruction	Wake-up + interrupt + next instruction	Interrupt	Interrupt
Counter 1 IOCF0 bit3=1	Х	Wake-up + interrupt + next instruction	Interrupt	Interrupt
Counter 2 IOCF0 bit4=1	Х	Wake-up + interrupt + next instruction	Interrupt	Interrupt
High-pulse timer IOCF0 bit5=1	х	Wake-up + interrupt + next instruction	Interrupt	Interrupt
Low-pulse timer IOCF0 bit6=1	Х	Wake-up + interrupt + next instruction	Interrupt	Interrupt
Port6, Port 8 (input status change wake-up) Bit 7 of IOCF0 = "0"	Wake-up + next instruction	Wake-up + next instruction	Х	Х
Port6, Port 8 (input status change wake-up) Bit 7 of IOCF0 = "1"	Wake-up + interrupt + next instruction	Wake-up + interrupt + next instruction	х	Х
WDT time out	Х	RESET	RESET	RESET

Note 1: Only external TCC pin can Wake-up from idle mode.



4.6 Oscillator

4.6.1 Oscillator Modes

This LSI can operate in the three different oscillator modes from main oscillator (R-OSCI, OSCO), such as RC oscillator with external resistor and Internal capacitor mode (ERIC); crystal oscillator mode; and PLL operation mode (R-OSCI connected $0.01\,\mu$ F capacitor to Ground). User can select one of them by programming FMMD1 and FMMD0 in the CODE options register. The sub-oscillator can be operated in crystal mode and ERIC mode. Table 3 below shows how these three modes are defined.

Table 3 Oscillator Modes as defined by FSMD, FMMD1, FMMD0.

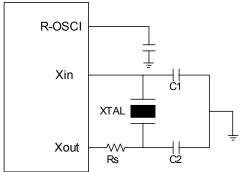
FSMD	FMMD1	FMMD0	Main clock	Sub-clock	
0	0	0	RC type (ERIC)	RC type (ERIC)	
0	0	1	Crystal type	RC type (ERIC)	
0	1	Х	PLL type	RC type (ERIC)	
1	0	0	RC type (ERIC)	Crystal type	
1	0	1	Crystal type	Crystal type	
1	1	Х	PLL type	Crystal type	

Table 4 Summary of maximum operating speeds

Conditions	VDD	Fxt max.(MHz)
	2.3	4
Two clocks	3.0	8
	5.0	10

4.6.2 Phase Lock Loop (PLL Mode)

When operate on PLL mode, the High frequency determined by sub-oscillator. We can choose RD register to change high oscillator frequency. The relation between high frequency (Fm) and sub-oscillator is shown as below table:



Circuit for PLL mode



CLK2	CLK1	CLK0	Main clock	Example Fs=32.768K			
0	0	0	Fs*130	4.26 MHz			
0	0	1	Fs*65	2.13 MHz			
0	1	0	Fs*65/2	1.065 MHz			
0	1	1	Fs*65/4	532 KHz			
1	Х	Х	Fs*244	8 MHz			

Bit 6~4 (CLK2~0) of RD: main clock selection bits for PLL mode (code option select)

4.6.3 Crystal Oscillator/Ceramic Resonators (XTAL)

This LSI can be driven by an external clock signal through the R-OSCI pin as shown in Fig.9 below.

In most applications, the R-OSCI pin and the OSCO pin can be connected with a crystal or ceramic resonator to generate oscillation. Fig. 10 depicts such circuit. Table 5 provides the recommended values of C1 and C2. Since each resonator has its own attribute, user should refer to its specification for appropriate values of C1 and C2. RS, a serial resistor, may be necessary for AT strip cut crystal or low frequency mode.

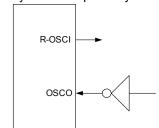


Fig.9 Circuit for External Clock Input

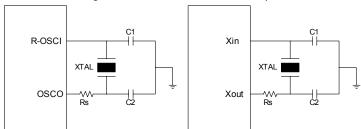


Fig. 10 Circuit for Crystal/Resonator

Table 5 Capacitor Selection Guide for Crystal Oscillator or Ceramic Resonators

Oscillator source	Oscillator Type	Frequency	C1 (pF)	C2 (pF)
	0	455 kHz	100~150	100~150
	Ceramic Resonators	2.0 MHz	20~40	20~40
	. 10001101010	4.0MHz	10~30	10~30
Main oscillator		455KHz	20~40	20~150
	Crystal Casillator	1.0MHz	15~30	15~30
	Crystal Oscillator	2.0MHz	15	15
		4.0MHz	15	15
Sub-oscillator	Crystal Oscillator	32.768kHz	25	25



4.6.4 RC Oscillator Mode with Internal Capacitor

If both precision and cost are taken into consideration, This LSI also offers a special oscillation mode, which is equipped with an internal capacitor and an external resistor connected to VDD. The internal capacitor functions as temperature compensator. In order to obtain more accurate frequency, a precise resistor is recommended.

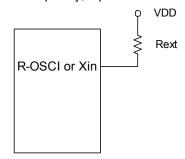


Fig. 11 Circuit for Internal C Oscillator Mode

Table 6 RC Oscillator Frequencies

Pin	Rext	Average Fosc 5V, 25°C	Average Fosc 3V, 25°C						
	51k	2.2221 MHz	2.1972 MHz						
R-OSCI	100k	1.1345 MHz	1.1203 MHz						
	300k	381.36KHz	374.77 KHz						
Xin	2.2M	32.768KHz	32.768KHz						

Note: Measured from QFP packages with frequency drift of about $\pm 30\%$. Values are provided for design reference only.

4.7 Power-on Considerations

Any microcontroller (as with this LSI) is not warranted to start operating properly before the power supply stabilizes in steady state. This LSI is equipped with Power On Reset (POR) with detection level range of 1.9V to 2.1V. The circuitry eliminates the extra external reset circuit but it will work well only if the VDD rises quickly enough (50 ms or less). However, under critical applications, extra devices are still required to assist in solving power-on problems.

4.7.1 External Power-on Reset Circuit

This circuit implements an external RC to produce a reset pulse (see Fig.12). The pulse width (time constant) should be kept long enough to allow VDD to reach minimum operation voltage. This circuit is used when the power supply rise time is slow. Because the current leakage from the /RESET pin is about $\pm 5\mu$ A, it is recommended that R should not be great than 40K. In this way, the voltage at Pin /RESET is held below 0.2V. The diode (D) acts as a short circuit at power-down. The capacitor, C, is discharged rapidly and fully. Rin, the current-limited resistor, prevents high current discharge or ESD (electrostatic discharge) from flowing into Pin /RESET.



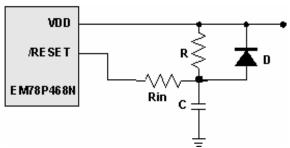


Fig. 12 External Power on Reset Circuit

4.7.2 Residue-Voltage Protection

When battery is replaced, device power (VDD) is disconnected but residue-voltage remains. The residue-voltage may trips below minimum VDD, but above zero. This condition may cause poor power on reset. Fig.13 and Fig.14 show how to build a residue-voltage protection circuit

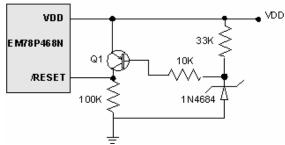


Fig. 13 Circuit 1 for the Residue Voltage Protection

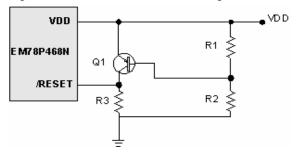


Fig. 14 Circuit 2 for the Residue Voltage Protection



4.8 Interrupt

This LSI has eight interrupt sources as listed below:

- TCC overflow interrupt.
- External interrupt P5.4/INTO pin
- External interrupt P5.5/INT1 pin
- Counter 1 underflow interrupt
- Counter 2 underflow interrupt
- High-pulse width timer underflow interrupt
- Low-pulse width timer underflow interrupt
- Port 6, Port 8 input status change wake-up

This IC has internal interrupts which are falling edge triggered or as follows:

- TCC timer overflow interrupt,
- Four 8-bits down-count timer underflow interrupt

If these interrupt sources change signal from high to low, the RF register will generate "1" flag to corresponding register if the IOCF0 register is enabled.

RF is the interrupt status register. It records the interrupt request in flag bit. IOCF0 is the interrupt mask register. Global interrupt is enabled by ENI instruction and disabled by DISI instruction. When one of the interrupts (when enabled) is generated, it will cause the next instruction to be fetch from address 0003H~0018H according to interrupt source.



With this LSI, each individual interrupt source has its own interrupt vector as depicted in Table 3. Before the interrupt subroutine is executed, the contents of ACC and the R3 register are initially saved by hardware. After the interrupt service routine is completed, ACC and R3 are restored. The existing interrupt service routine does not allow other interrupt service routine to be executed. So if other interrupts occur while the existing interrupt service routine is being executed, the hardware will save the later interrupts. Only after the existing interrupt service routine is completed that the next interrupt service routine is executed.

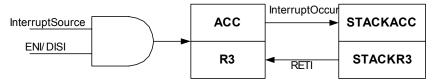


Fig. 15. Interrupt Backup Diagram

Table 3 Interrupt Vector

Interrupt Vector	Interrupt Status
0003H	TCC overflow interrupt.
0006H	External interrupt P5.4/INT0 pin
0009H	External interrupt P5.5/INT1 pin
000CH	Counter 1 underflow interrupt
000FH	Counter 2 underflow interrupt
0012H	High-pulse width timer underflow interrupt
0015H	Low-pulse width timer underflow interrupt
0018H	PORT 6, PORT 8 input status change wake-up



4.9 LCD Driver

This LSI can drive LCD of up to 32 segments and 4 commons that can drive 4*32 dots totally. LCD block is made up of LCD driver, display RAM, segment output pins, common output pins, and LCD operating power supply pins. This circuit works on normal mode, green mode and idle mode. The LCD duty; bias; the number of segment; the number of common and frame frequency are determined by the LCD controller register.

The basic structure contains a timing control that uses a subsystem clock to generate the proper timing for different duty and display accesses. The R9 register is a command register for LCD driver which includes LCD enable/disable, bias (1/2 and 1/3), duty (1/2, 1/3, 1/4), and LCD frame frequency control. The register RA is an LCD contrast and LCD RAM address control register. The register RB is an LCD RAM data buffer. LCD booster circuit can change operation frequency to improve VLCD2 and VLCD3 drive capability. The control register is explained as follows.

R9/LCDCR (LCD Control Register)

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
BS	DS1	DS0	LCDEN		LCDTYPE	LCDF1	LCDF0

Bit 7 (BS): LCD bias select bit, 0/1=>(1/2 bias) / (1/3 bias)

Bit 6 ~ 5 (DS1 ~ DS0): LCD duty select

DS1	DS0	LCD Duty
0	0	1/2 duty
0	1	1/3 duty
1	X	1/4 duty

Bit 4 (LCDEN): LCD enable bit: 0/1 -> LCD circuit disable/enable

When LCD function is disabled, all common/segment output is set to ground (GND) level

Bit 3: Not used

Bit 2 (LCDTYPE): LCD drive waveform type select bit

LCDTYPE = "0": "A" type waveform **LCDTYPE = "1":** "B" type waveform

Bit 1 ~ 0(LCDF1 ~ LCDF0): LCD frame frequency control bits

LCDF1	LCDF0	LCD frame frequency (e.g. Fs=32.768KHz)					
LCDFI		1/2 duty	1/3 duty	1/4 duty			
0	0	Fs/(256*2)=64.0	Fs/(172*3)=63.5	Fs/(128*4) =64.0			
0	1	Fs/(280*2)=58.5	Fs/(188*3)=58.0	Fs/(140*4) =58.5			
1	0	Fs/(304*2)=53.9	Fs/(204*3)=53.5	Fs/(152*4) =53.9			
1	1	Fs/(232*2)=70.6	Fs/(156*3)=70.0	Fs/(116*4) =70.6			

Fs: sub-oscillator frequency



RA/LCD_ADDR (LCD Address)

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0	0	0	LCD_A4	LCD_A3	LCD_A2	LCD_A1	LCD_A0

Bit 7 ~ 5: Not used, fixed to "0"

Bit 4 ~ 0 (LCDA4 ~ LCDA0): LCD RAM address

RA		RB (L	CD data I	ouffer)		
(LCD address)	Bit 7 ~4	Bit 3 (LCD_D3)	Bit 2 (LCD_D2)	Bit 1 (LCD_D1)	Bit 0 (LCD_D0)	Segment
00H						SEG0
01H						SEG1
02H						SEG2
I						I
1DH	ı					SEG29
1EH	ı					SEG30
1FH						SEG31
Common	X	СОМЗ	COM2	COM1	СОМО	

RB/LCD_DB (LCD Data Buffer)

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
				LCD_D 3	LCD_D 2	LCD_D 1	LCD_D 0

Bit 7 ~ 4: Not used

Bit 3 ~ 0 (LCD_D3 ~ LCD_D0): LCD RAM data transfer registers

RD/SBPCR (System, Booster and PLL Control Registers)

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
	CLK2	CLK1	CLK0	IDLE	BF1	BF0	CPUS

Bit 2 ~ 1 (BF1 ~ 0): LCD booster frequency select bits

BF1	BF0	Booster frequency
0	0	Fs
0	1	Fs/4
1	0	Fs/8
1	1	Fs/16



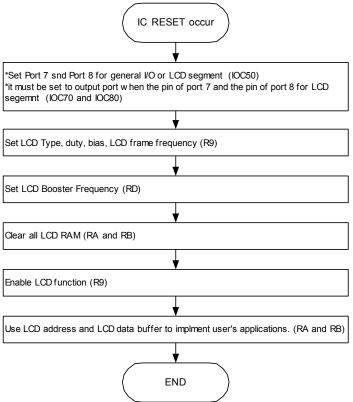


Fig.16. The Initial Setting Flowchart for LCD Function



The connecting of boosting circuits for LCD voltage is as below:

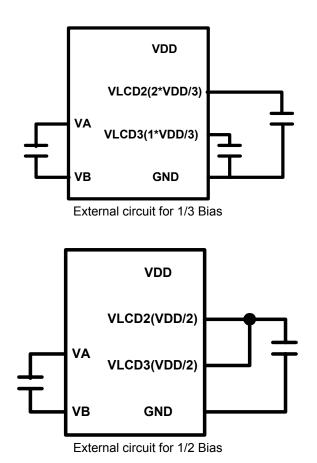


Fig. 17 The Connection of Charge Bump Circuit (Cext=0.1uf)



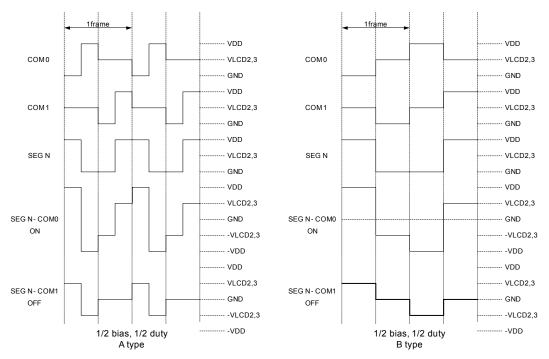


Fig. 18 LCD Waveform for 1/2 Bias, 1/2 Duty

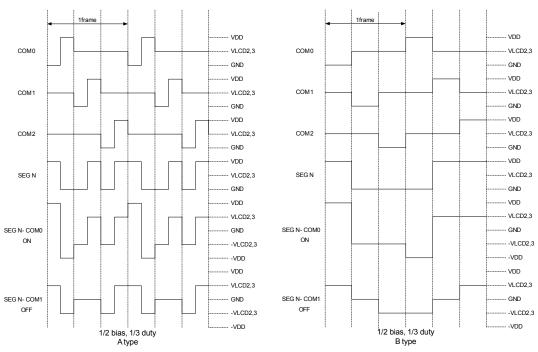


Fig. 19 LCD Waveform for 1/2 Bias, 1/3 Duty



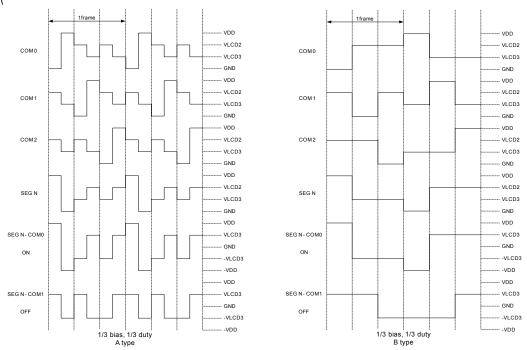


Fig. 20 LCD Waveform for 1/3 Bias, 1/3 Duty

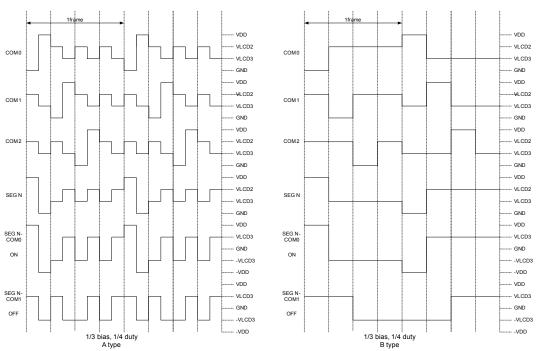


Fig. 21 LCD Waveform for 1/3 Bias, 1/4 Duty



4.10 Infrared Remote Control Application / PWM Waveform Generate

This LSI can output infrared carrier in a friendly manner or in PWM standard waveform. The IR and PWM waveform generated functions include an 8-bits down-count timer, high-pulse width timer, low-pulse width timer, and IR control register. The IR system block diagram is show in Fig.21, The IROUT pin waveform is determined by IR control register (RE), IOC90 (Counter 1, 2 control register), IOCA0 (high-pulse width timer, low-pulse width timer control register), IOCC0 (Counter 2 preset), IOCD0 (high-pulse width timer preset register), and IOCE0 (low-pulse width timer preset register). Details on Fcarrier, high-pulse time, and low pulse time are explained as follows:

If Counter 2 source clock is F_T (this clock source can set by IOC91);

$$F_{carrier} = \frac{F_{T}}{2*(1+decimal of counter 2 preset value(IOCC0))*prescaler}$$

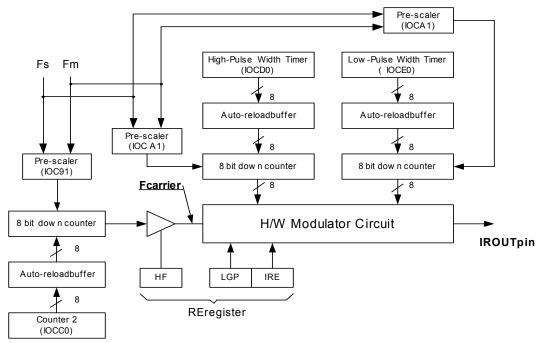
If high-pulse width timer source clock is FT (this clock source can set by IOCA1);

$$T_{\text{high pulse time}} = \frac{\text{prescaler} * (1 + \text{decimal of high pulse width timer value(IOCD0)})}{F_{\text{T}}}$$

If low-pulse width timer source clock is FT (this clock source can set by IOCA1);

$$T_{low\ pulse\ time} = \frac{prescaler * (1 + decimal\ of\ low\ pulse\ width\ timer value(IOCE0))}{F_{T}}$$





Fm: main oscillator frequency; Fs: sub-oscillator frequency Fig. 21 IR/PWM System Block Diagram

The IROUT output waveform is further explained in the following figures:

- **Fig. 22:** LGP=0, HF=1, the IROUT waveform can modulate Fcarrier waveform when in low-pulse width time.
- **Fig. 23:** LGP=0, HF=0, the IROUT waveform cannot modulate Fcarrier waveform when in low-pulse width time. So IROUT waveform is determined by high-pulse time and low-pulse time. This mode can produce standard PWM waveform
- **Fig. 24:** LGP=0, HF=1, the IROUT waveform can modulate Fcarrier waveform when in low-pulse width time. When IRE goes from high to low, the output waveform of IROUT will keep on transmitting till high-pulse width timer interrupt occurs.
- **Fig. 25:** LGP=0, HF=0, the IROUT waveform can not modulate Fcarrier waveform when in low-pulse width time. So IROUT waveform is determined by high-pulse time and low-pulse time. This mode can produce standard PWM waveform. When IRE goes from high to low, the output waveform of IROUT will keep on transmitting till high-pulse width timer interrupt occurs.
- **Fig.26:** LGP=1, when this bit is set to high level, the high-pulse width timer is ignored. So IROUT waveform output from low-pulse width timer is established.



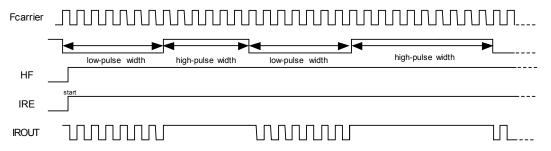
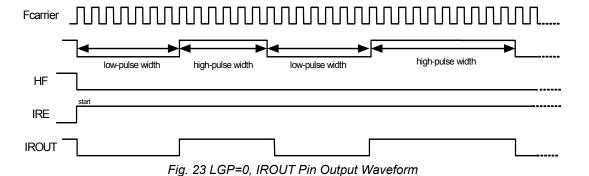


Fig. 22 LGP=0, IROUT Pin Output Waveform



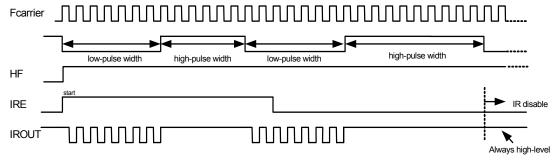


Fig. 24 LGP=0, IROUT Pin Output Waveform

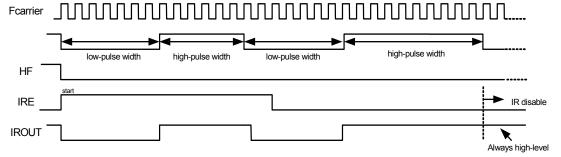


Fig. 25 LGP=0, IROUT Pin Output Waveform

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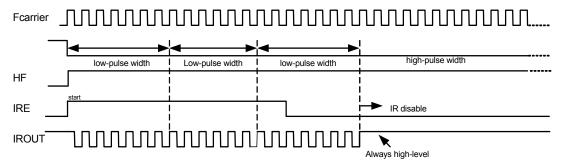


Fig. 26 LGP=1, IROUT Pin Output Waveform

IR/PWM function enable flowchart

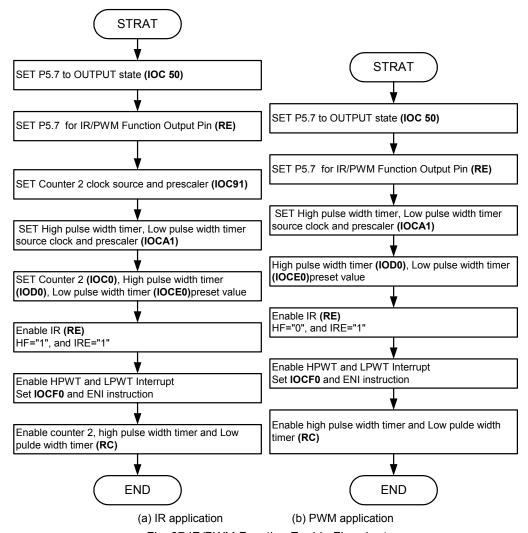


Fig. 27 IR/PWM Function Enable Flowchart



4.11 Code Options

The EM78468 has one Code Option word that is not a part of the normal program memory.

Code Option Register (Word 0)

	Word 0									
Bit12~10	Bit9	Bit8	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
1	CYES	HLFS	ENWDTB	FSMD	FMMD1	FMMD0	HLP	0	0	0

• Bit 12 ~ 10: Not used.

These bits are set to "1" all the time.

• Bit 9 (CYES): Cycle select for JMP and CALL instructions

CYES = "0": only one instruction cycle (JMP or CALL) can be executed

CYES = "1": two instructions cycles (JMP and CALL) can be executed

• Bit 8 (HLFS): main or sub-oscillator select

HLFS = "0": CPU is set to select sub-oscillator when reset occurs.

HLFS = "1": CPU is set to select main-oscillator when reset occurs.

• Bit 7(ENWDTB): Watchdog timer enable/disable bit.

ENWDTB = "0": Enable watchdog timer.

ENWDTB = "1": Disable watchdog timer.

• Bit 6 (FSMD): sub-oscillator type selection.

• Bit 5, 4 (FMMD1, 0): main Oscillator type selection.

FSMD	FMMD1	FMMD0	Main Oscillator Type	Sub Oscillator Type
0	0	0	RC type	RC type
0	0	1	XTAL type	RC type
0	1	Х	PLL type	RC type
1	0	0	RC type	XTAL type
1	0	1	XTAL type	XTAL type
1	1	Х	PLL type	XTAL type

• Bit 3 (HLP): Power consumption selection. If your system usually runs in green mode, it must be set to low power consumption to help support the energy saving issue. We recommend that low power consumption mode is slected.

HLP = "0": Low power consumption mode

HLP = "1": High power consumption mode

• Bit 2~0:

These bits are set to "0" all the time.

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4.12 Instruction Set

Each instruction in the instruction set is a 13-bit word divided into an OP code and one or more operands. Normally, all instructions are executed within one single instruction cycle (one instruction consists of 2 oscillator periods), unless the program counter is changed by instruction "MOV R2,A", "ADD R2,A", or by instructions of arithmetic or logic operation on R2 (e.g. "SUB R2,A", "BS(C) R2,6", "CLR R2", ····). In this case, the execution takes two instruction cycles.

If for some reasons, the specification of the instruction cycle is not suitable for certain applications, try modifying the instruction as follows:

Execute within two instruction cycles the "JMP", "CALL", "RETL", & "RETL" instructions, or the conditional skip instructions ("JBS", "JBC", "JZ", "JZA", "DJZ", "DJZA") which were tested to be true. Also execute within two instruction cycles the instructions that are written to the program counter.

Additionally, the instruction set offers the following features:

- (1) Every bit of any register can be set, cleared, or tested directly.
- (2) The I/O register can be regarded as general register. That is, the same instruction can operate on I/O register.

The symbol "R" represents a register designator that specifies which one of the registers (including operational registers and general purpose registers) is to be utilized by the instruction. "b" represents a bit field designator that selects the value for the bit that is located in the register "R", and affects operation. "k" represents an 8 or 10-bit constant or literal value.



INST	RUCT	ION	HEX	MNE	MON	IIC -	OPERATION	STATUS
=	INARY				WON	nC	OPERATION	AFFECTED
0 0000	0000	0000	0000	NOP			No Operation	None
0 0000	0000	0001	0001	DAA			Decimal Adjust A	С
0 0000	0000	0011	0003	SLEP			0 → WDT, Stop oscillator	T, P
0 0000	0000	0100	0004	WDTC			$0 \rightarrow WDT$	T, P
0 0000	0000	rrrr	000r	IOW	R		$A \rightarrow IOCR$	None <note1></note1>
0 0000	0001	0000	0010	ENI			Enable Interrupt	None
0 0000	0001	0001	0011	DISI			Disable Interrupt	None
0 0000	0001	0010	0012	RET			[Top of Stack] → PC	None
0 0000	0001	0011	0013	RETI			[Top of Stack] → PC, Enable Interrupt	None
0 0000	0001	rrrr	001r	IOR	R		IOCR → A	None <note1></note1>
0 0000	01rr	rrrr	00rr	MOV	R,	Α	$A \rightarrow R$	None
0 0000	1000	0000	0800	CLRA			$0 \rightarrow A$	Z
0 0000	11rr	rrrr	00rr	CLR	R		$0 \rightarrow R$	Z
0 0001	00rr	rrrr	01rr	SUB	Α,	R	$R-A \rightarrow A$	Z, C, DC
0 0001	01rr	rrrr	01rr	SUB	R,	Α	$R-A \rightarrow R$	Z, C, DC
0 0001	10rr	rrrr	01rr	DECA	R		$R-1 \rightarrow A$	Z
0 0001	11rr	rrrr	01rr	DEC	R		$R-1 \rightarrow R$	Z
0 0010	00rr	rrrr	02rr	OR	Α,	R	$A \lor R \to A$	Z
0 0010	01rr	rrrr	02rr	OR	R,	Α	$A \lor R \to R$	Z
0 0010	10rr	rrrr	02rr	AND	Α,	R	$A \& R \rightarrow A$	Z
0 0010	11rr	rrrr	02rr	AND	R,	Α	$A \& R \rightarrow R$	Z
0 0011	00rr	rrrr	03rr	XOR	A,	R	$A \oplus R \rightarrow A$	Z
0 0011	01rr	rrrr	03rr	XOR	R,	Α	$A \oplus R \rightarrow R$	Z
0 0011	10rr	rrrr	03rr	ADD	A,	R	$A + R \rightarrow A$	Z, C, DC
0 0011	11rr	rrrr	03rr	ADD	R,	Α	$A + R \rightarrow R$	Z, C, DC
0 0100	00rr	rrrr	04rr	MOV	A,	R	$R \rightarrow A$	Z
0 0100	01rr	rrrr	04rr	MOV	R,	R	$R \rightarrow R$	Z
0 0100	10rr	rrrr	04rr	COMA	R		$/R \rightarrow A$	Z
0 0100	11rr	rrrr	04rr	COM	R		$/R \rightarrow R$	Z
0 0101	00rr	rrrr	05rr	INCA	R		R+1 → A	Z
0 0101	01rr	rrrr	05rr	INC	R		$R+1 \rightarrow R$	Z
0 0101	10rr	rrrr	05rr	DJZA	R		$R-1 \rightarrow A$, skip if zero	None
0 0101	11rr	rrrr	05rr	DJZ	R		$R-1 \rightarrow R$, skip if zero	None
0 0110	00rr	rrrr	06rr	RRCA	R		R(n) (A(n-1), R(0) (C, C (A(7)	С
0 0110	01rr	rrrr	06rr	RRC	R		R(n) (R(n-1), R(0) (C, C (R(7)	С
0 0110	10rr	rrrr	06rr	RLCA	R		R(n) (A(n+1), R(7) (C, C (A(0)	С
0 0110	11rr	rrrr	06rr	RLC	R		R(n) (R(n+1), R(7) (C, C (R(0)	С
0 0111	00rr	rrrr	07rr	SWAPA	R		R(0-3) (A(4-7), R(4-7) (A(0-3)	None
0 0111	01rr	rrrr	07rr	SWAP	R		R(0-3) (R(4-7)	None
0 0111	10rr	rrrr	07rr	JZA	R		R+1 (A, skip if zero	None
0 0111	11rr	rrrr	07rr	JZ	R		R+1 (R, skip if zero	None
0 100b	bbrr	rrrr	0xxx	ВС	R,	b	0 (R(b)	None
0 101b	bbrr	rrrr	0xxx	BS	R,	b	1 (R(b)	None

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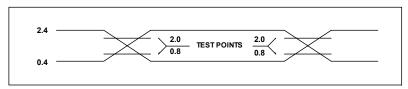


	TRUCTI BINARY		HEX	MNE	MONIC	OPERATION	STATUS AFFECTED
0 110b	bbrr	rrrr	0xxx	JBC	R, b	if R(b)=0, skip	None
0 111b	bbrr	rrrr	0xxx	JBS	R, b	if R(b)=1, skip	None
1 00kk	kkkk	kkkk	1kkk	CALL	k	$PC+1 \rightarrow [SP],$ $(Page, k) \rightarrow PC$	None
1 01kk	kkkk	kkkk	1kkk	JMP	k	$(Page, k) \rightarrow PC$	None
1 1000	kkkk	kkkk	18kk	MOV	A, k	$k \rightarrow A$	None
1 1001	kkkk	kkkk	19kk	OR	A, k	$A \lor k \to A$	Z
1 1010	kkkk	kkkk	1Akk	AND	A, k	$A \& k \rightarrow A$	Z
1 1011	kkkk	kkkk	1Bkk	XOR	A, k	$A \oplus k \rightarrow A$	Z
1 1100	kkkk	kkkk	1Ckk	RETL	k	$k \rightarrow A$, [Top of Stack] $\rightarrow PC$	None
1 1101	kkkk	kkkk	1Dkk	SUB	A, k	$k-A \rightarrow A$	Z, C, DC
1 1110	1000	00kk	1E8k	PAGE	k	k->R5(1:0)	None
1 1110	1001	00kk	1E9K	BANK	k	k->R4(7:6)	None
1 1111	kkkk	kkkk	1Fkk	ADD	A, k	$k+A \rightarrow A$	Z, C, DC

<Note1> This instruction is applicable to IOC50 ~ IOCF0, IOC61 ~ IOCE1

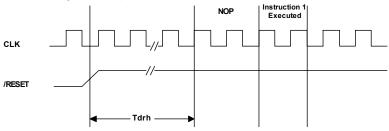
4.13 **Timing Diagram**

AC Test Input/Output Waveform

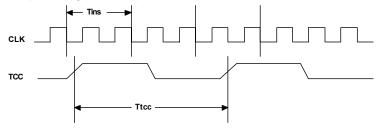


AC Testing : Input is driven at 2.4V for logic "1",and 0.4V for logic "0".Timing measurements are made at 2.0V for logic "1",and 0.8V for logic "0".

RESET Timing (CLK="0")



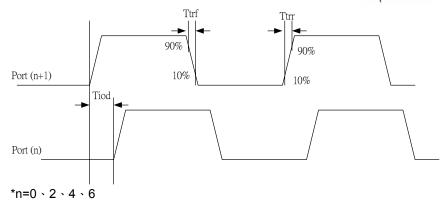
TCC Input Timing (CLKS="0")



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5 ABSOLUTE MAXIMUM RATINGS

Items	Symbol	Condition	Rat	ting	Hnit
items	Symbol	Condition	Min.	Max.	Unit
Supply voltage	VDD		GND-0.3	+7.0	V
Input voltage	Vı	PORT 5, PORT 6, PORT 7, PORT 8	GND-0.3	VDD+0.3	V
Output voltage	Vo	PORT 5, PORT 6, PORT 7, PORT 8	GND-0.3	VDD+0.3	٧
Operation temperature	T _{OPR}		0	70	$^{\circ}\mathbb{C}$
Storage temperature	T _{STG}		-65	150	$^{\circ}\mathbb{C}$
Power dissipation	P_D			500	mW
Operating Frequency			32.768K	10M	Hz



6 ELECTRICAL CHARACTERISTIC

6.1 DC ELECTRICAL CHARACTERISTICS

(Ta= 25 °C, VDD= 5.0V, GND= 0V)

Parameter	Condition	Min.	Тур.	Max.	Unit
XTAL: VDD to 5V	Two cycle with two clocks	32.768K	8M	10M	Hz
Sub-oscillator	Two cycle with two clocks		32.768		KHz
External R, internal C for sub-oscillator	R: 300KΩ, internal capacitance	270	384	500	KHz
External R, internal C for sub-oscillator	R: 2.2MΩ, internal capacitance	22.9	32.768	42.6	KHz
Input Leakage Current for input pins	VIN = VDD, GND	-1	0	1	μА
I Input High Threshold Voltage (Schmitt trigger)	Ports 5, 6, 7, 8	2.4			V
Input High Threshold Voltage (Schmitt trigger)	Ports 5, 6, 7, 8			0.8	V
Input High Threshold Voltage (Schmitt trigger)	/RESET	2.4			٧
Input Low Threshold Voltage (Schmitt trigger)	/RESET			0.8	٧
Input High Threshold Voltage (Schmitt trigger)	TCC, INT0, INT1	2.4			V
Input Low Threshold Voltage (Schmitt trigger)	TCC, INTO, INT1			0.8	٧
Output High Voltage (Ports 5, 6, 7, 8)	VOH = 2.4V, IROCS="0"	-9			mA
Output Low Voltage (Ports 5, 6, 7, 8)	VOL = 0.4V, IROCS="0"			9	mA
Output high voltage (P5.7/IROUT pin)	VOH = 2.4V, IROCS="1"	-18			mA
Output Low Voltage (P5.7/IR OUT pin)	VOL = 0.4V, IROCS="1			18	mA
Pull-high current	Pull-high active, input pin at GND	-55	-75	-95	μА
Pull-low current	Pull-low active, input pin at VDD	55	75	95	μА
Sleep mode current	All input and I/O pins at VDD, output pin floating, WDT disabled		0.5	1.5	μА
Idle mode current	/RESET= 'High', CPU OFF, sub-oscillator clock (32.768KHz) ON, output pin floating, LCD enable, no load		14	18	μА
Green mode current	/RESET= 'High', CPU ON, used sub-oscillator clock (32.768KHz), output pin floating, WDT enabled, LCD enable		22	30	μА
Normal mode	/RESET= 'High', Fosc=4MHz (Crystal type, CLKS="0"), output pin floating		2.2	3	mA
Normal mode	/RESET= 'High', Fosc=10MHz (Crystal type, CLKS="0"), output pin floating		3.1	4	mA
	Sub-oscillator External R, internal C for sub-oscillator External R, internal C for sub-oscillator Input Leakage Current for input pins I Input High Threshold Voltage (Schmitt trigger) Input High Threshold Voltage (Schmitt trigger) Input High Threshold Voltage (Schmitt trigger) Input Low Threshold Voltage (Schmitt trigger) Input High Threshold Voltage (Schmitt trigger) Input Low Threshold Voltage (Schmitt trigger) Input High Threshold Voltage (Schmitt trigger) Input High Threshold Voltage (Schmitt trigger) Output High Voltage (Schmitt trigger) Output Low Voltage (Ports 5, 6, 7, 8) Output Low Voltage (P5.7/IROUT pin) Output Low Voltage (P5.7/IR OUT pin) Pull-high current Pull-low current Idle mode current Green mode current Normal mode	XTAL: VDD to 5V Two cycle with two clocks Sub-oscillator Two cycle with two clocks External R, internal C for sub-oscillator R: 300ΚΩ, internal capacitance External R, internal C for sub-oscillator R: 2.2MΩ, internal capacitance Input Leakage Current for input pins VIN = VDD, GND I Input High Threshold Voltage (Schmitt trigger) Ports 5, 6, 7, 8 Input High Threshold Voltage (Schmitt trigger) /RESET Input High Threshold Voltage (Schmitt trigger) /RESET Input Low Threshold Voltage (Schmitt trigger) /RESET Input High Threshold Voltage (Schmitt trigger) /RESET Input Low Threshold Voltage (Schmitt trigger) TCC, INT0, INT1 Input Low Threshold Voltage (Schmitt trigger) VOH = 2.4V, IROCS="0" Output High Voltage (Ports 5, 6, 7, 8) VOH = 2.4V, IROCS="0" Output Low Voltage (Ports 5, 6, 7, 8) VOL = 0.4V, IROCS="0" Output high voltage (P5.7/IROUT pin) VOH = 2.4V, IROCS="1" Output Low Voltage (P5.7/IR OUT pin) VOL = 0.4V, IROCS="1" Pull-high current Pull-high active, input pin at GND Pull-low current Pull-high active, input pin at VDD, output pin floating, WDT disabled Idle mode current All input and I/O pins at VD	XTAL: VDD to 5V Two cycle with two clocks Sub-oscillator Two cycle with two clocks External R, internal C for sub-oscillator R: 300ΚΩ, internal capacitance 270 External R, internal C for sub-oscillator R: 2.2ΜΩ, internal capacitance 22.9 Input Leakage Current for input pins VIN = VDD, GND -1 Input High Threshold Voltage (Schmitt trigger) Ports 5, 6, 7, 8 2.4 Input High Threshold Voltage (Schmitt trigger) RESET 2.4 Input High Threshold Voltage (Schmitt trigger) RESET 2.4 Input Low Threshold Voltage (Schmitt trigger) RESET 2.4 Input High Threshold Voltage (Schmitt trigger) RESET 2.4 Input Low Threshold Voltage (Schmitt trigger) TCC, INT0, INT1 2.4 Input High Voltage (Schmitt trigger) TCC, INT0, INT1 2.4 Input Low Threshold Voltage (Schmitt trigger) TCC, INT0, INT1 2.4 Input Low Unitage (Ports 5, 6, 7, 8) VOH = 2.4V, IROCS="0" 9 Output High Voltage (Ports 5, 6, 7, 8) VOL = 0.4V, IROCS="0" -18 Output Low Voltage (PS.7/IROUT pin) VOH = 2.4V, IROCS="1" -18 Output Low Voltage (PS.7/IROUT pin) VOH	XTAL: VDD to 5V	XTAL: VDD to 5V



(Ta= 25 °C, VDD= 3.0V, GND= 0V)

Symbo	l Parameter	Condition	Min.	Тур.	Max.	Unit
FXT	XTAL: VDD to 5V	Two cycle with two clocks	32.768K	8M	10M	Hz
Fs	Sub-oscillator	Two cycle with two clocks		32.768		KHz
ERIC	External R, internal C for sub-oscillator	R: 300KΩ, internal capacitance	270	384	500	KHz
	External R, internal C for sub-oscillator	R: 2.2MΩ, internal capacitance	22.9	32.768	42.6	KHz
IIL	Input Leakage Current for input pins	VIN = VDD, GND	-1	0	1	μА
VIH1	Input High Threshold Voltage (Schmitt trigger)	Ports 5, 6, 7, 8	1.8			V
VIL1	Input Low Threshold Voltage (Schmitt trigger)	Ports 5, 6, 7, 8			0.6	V
VIHT1	Input High Threshold Voltage (Schmitt trigger)	/RESET	1.8			V
VILT1	Input Low Threshold Voltage (Schmitt trigger)	/RESET			0.6	٧
VIHT2	Input High Threshold Voltage (Schmitt trigger)	TCC, INT0, INT1	1.8			٧
VILT2	Input Low Threshold Voltage (Schmitt trigger)	TCC, INT0, INT1			0.6	V
IOH1	Output High Voltage (Ports 5, 6, 7, 8)	VOH = 2.4V, IROCS="0"	-1.8			mA
IOL1	Output Low Voltage (Ports 5, 6, 7, 8)	VOL = 0.4V, IROCS="0"			6	mA
IOH1	Output high voltage (P5.7/IROUT pin)	VOH = 2.4V, IROCS="1	-3.5			mA
IOL2	Output Low Voltage (P5.7/IR OUT pin)	VOL = 0.4V, IROCS="1			12	mA
IPH	Pull-high current	Pull-high active, input pin at GND	-16	-23	-30	μА
IPL	Pull-low current	Pull-low active, input pin at VDD	16	23	30	μΑ
ISB	Sleep mode current	All input and I/O pins at VDD, output pin floating, WDT disabled		0.1	1	μА
ICC1	Idle mode current	/RESET= 'High', CPU OFF, sub-oscillator clock (32.768KHz) ON, output pin floating, LCD enable, no load	_	4	8	μА
ICC2	Green mode current	/RESET= 'High', CPU ON, used sub-oscillator clock (32.768KHz), output pin floating, WDT enabled, LCD enable		10	20	μА
ICC3	Normal mode	/RESET= 'High', Fosc=4MHz (Crystal type, CLKS="0"), output pin floating		0.73	1.2	mA
		•				



6.2 AC Electrical Characteristics

(Ta=- 40°C ~ 85 °C, VDD=5V±5%, GND=0V)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Dclk	Input CLK duty cycle		45	50	55	%
Tins	Instruction cycle time (CLKS="0")	Crystal type	100		DC	ns
		RC type	500		DC	ns
Ttcc	TCC input period		(Tins+20)/N*			ns
Tdrh	Device reset hold time	Ta = 25°C	11.3	16.2	21.6	ms
Trst	/RESET pulse width	Ta = 25°C	2000			ns
Twdt	Watchdog timer period	Ta = 25°C	11.3	16.2	21.6	ms
Tset	Input pin setup time			0		ns
Thold	Input pin hold time			20		ns
Tdelay	Output pin delay time	Cload=20pF		50		ns

^{*} N= selected pre-scaler ratio.



7 APPLICATION CIRCUIT

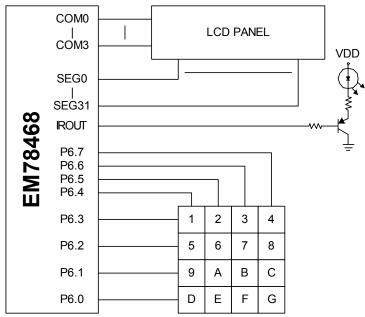


Fig. 28 IROUT control external BJT circuit to drive infrared emitting diodes

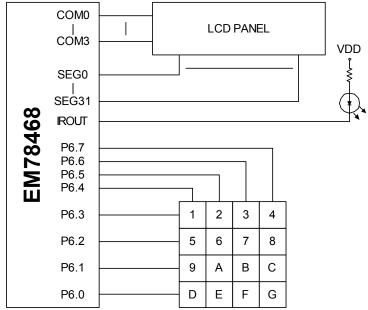


Fig. 29 IROUT direct drive infrared emitting diodes



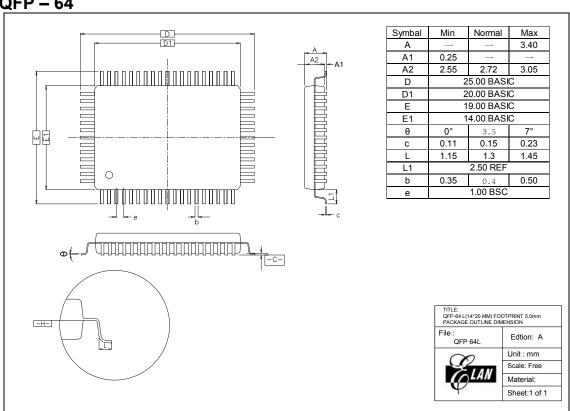
APPENDIX A

A.1 Package Types

Name	Package Type	Pin Count	Package Body Size
EM78468H	Dice	59	
EM78468Q	QFP	64	14 mm * 20 mm
EM78468AQ	LQFO	64	7 mm * 7mm
EM78468BQ	LQFP	44	10 mm * 10 mm
EM78468CQ	QFP	44	10 mm * 10 mm

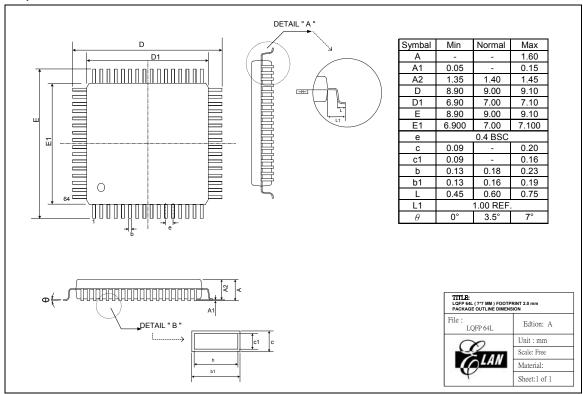
A.2 Package Information

QFP - 64



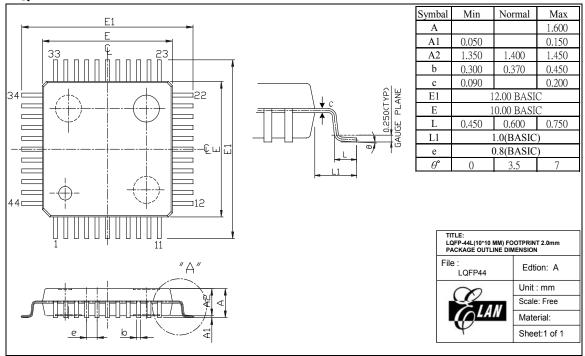


LQFP - 64



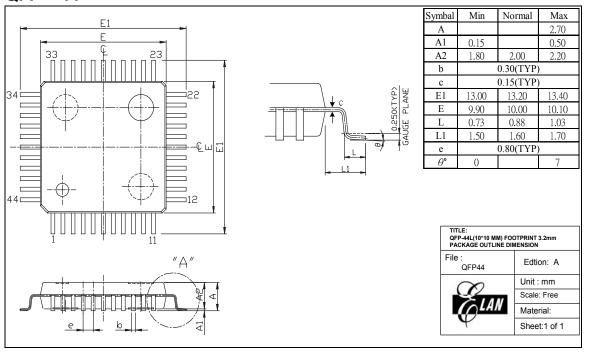


LQFP - 44





QFP - 44



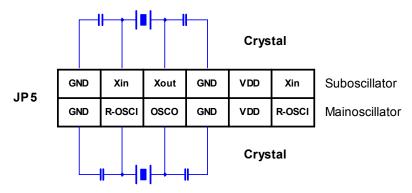


APPENDIX B

B.1 ICE 468XA Oscillator circuit (JP 5)

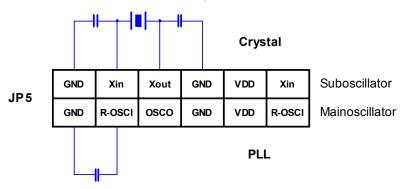
Mode1:

Main oscillator: Crystal mode, Sub oscillator: Crystal mode



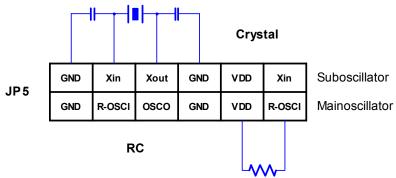
Mode2:

Main oscillator: PLL mode, Sub oscillator: Crystal mode



Mode3:

Main oscillator: RC mode, Sub oscillator: Crystal

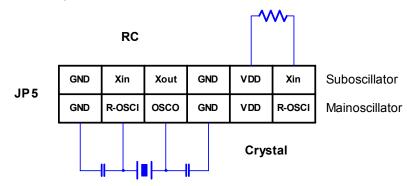


Product Specification (V1.1) 04.11.2005



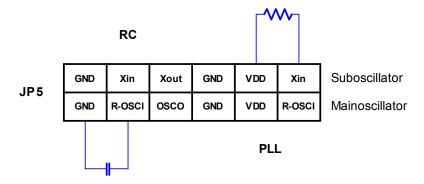
Mode4:

Main oscillator: Crystal mode, Sub oscillator: RC mode



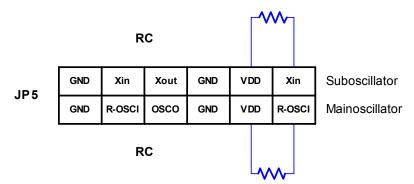
Mode5:

Main oscillator: PLL mode, Sub oscillator: RC mode



Mode6:

Main oscillator: RC mode, Sub oscillator: RC mode



Product Specification (V1.1) 04.11.2005



B.2 ICE 468XA output pin assignment (JP 3)

